

## DSP32C Digital Signal Processor with External Memory Interface

### Introduction

AT&T is an industry leader in floating-point digital signal processing. AT&T's DSP32 architecture was introduced in 1985 and is now the accepted standard in the speech, signal processing, and telecommunications application areas.

The DSP32C device offers more than three times the throughput of the DSP32 while offering pin, source code, and object code upward compatibility. In addition to powerful DSP devices, AT&T offers application support to its customers. Application support is supplied by field engineers, application notes, application software, and a 24-hour bulletin board.

Software and hardware development tools are available from both AT&T and third parties to speed development schedules. These tools include a device software simulator, hardware development board, and in-circuit emulator. The DSP32C product family offers high processing power, ease of use, and excellent development support.

### Description

The AT&T DSP32C Digital Signal Processor is a 32-bit, floating-point, programmable integrated circuit. As the second generation to the DSP32, it has access to a large base of both software and hardware support.

The DSP32C is fabricated in AT&T's high-speed, low-power CMOS technology. Packaging options for the DSP32C with External Memory Interface include a standard 133-pin, square ceramic pin-grid-array (CPGA) package and a 164-pin, JEDEC standard bumpered quad flat pack (BQFP) package.

Two execution units, the control arithmetic unit (CAU) and the data arithmetic unit (DAU), operate in parallel to achieve high throughput. The CAU performs 16- or 24-bit fixed-point arithmetic for logic and control functions. This unit, which includes 22 general-purpose registers, can execute 20 million instructions per second (MIPS). The DAU performs 32-bit floating-point arithmetic for signal processing functions. Four 40-bit accumulators are used as inputs/outputs to a floating-point multiplier and a floating-point adder that work in parallel to perform 40 million floating-point operations per second (MFLOPS).

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| Device Code | RAM           | Instruction Cycle Time | External Memory<br>Interface | Package  |
|-------------|---------------|------------------------|------------------------------|----------|
| DSP32C-R35  | 3 - 0.5K x 32 | 80 ns, 60 ns, or 50 ns | Yes                          | 133 CPGA |
| DSP32C-F35  | 3 - 0.5K x 32 | 80 ns, 60 ns, or 50 ns | Yes                          | 164 BQFP |
| DSP32C-M4*  | 4 - 0.5K x 32 | 80 ns, 70 ns           | No                           | 68 PLCC  |

### Table 1. DSP32C Products

\* This version of the DSP32C is described in the AT&T DSP32C Without External Memory Interface Data Sheet.

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### **Description** (continued)

#### Table 2. Features and Benefits of the DSP32C

| Features   | Benefits  |
|--|---|
| Full 32-bit floating-point architecture                      | Simplifies program development to provide faster              |
| Increased precision & dynamic range                          | time to market  |
|  | Much easier algorithm development opens up                    |
|  | new application possibilities                                 |
| Instruction started every instruction cycle                  | Allows more complex functions or a greater num-               |
|  | ber of simultaneous functions to be implemented               |
| Four memory accesses per instruction cycle                   | Eliminates memory accessing bottlenecks                       |
| Exceptional memory bandwidth                                 |   |
| C-like assembly language                                     | Easy to learn/excellent readability                           |
| Serial and parallel ports with DMA                           | Clean interface to external devices                           |
| High bandwidth, nonintrusive I/O                             | Lower system cost   |
|  | Easy interface to PC buses                                    |
|  | External control via parallel I/O (PIO)                       |
| Hardware data format conversions                             | Eliminates lengthy software routines                          |
| <ul> <li>IEEE* P754 floating-point</li> </ul>                | Permits shared data with host processor or other              |
|  | platforms   |
| Integer conversions:   | Increased throughput in:                                      |
| 8-bit unsigned   | <ul> <li>Graphics and image processing</li> </ul>             |
| 16-bit linear  | <ul> <li>Applications with 16-bit data</li> </ul>             |
| 24-bit linear  | <ul> <li>HQ digital audio and control applications</li> </ul> |
| <ul> <li>μ-law/A-law conversions</li> </ul>                  | <ul> <li>Telecom and speech applications</li> </ul>           |
| Fully vectored interrupt structure with hardware             | Allows very fast interrupt processing (up to                  |
| context save   | 2 million interrupts/s)                                       |
| Byte-addressable address space                               | Efficient storage of 8- and 16-bit data                       |
|  | Lower system cost   |
| Flexible wait-state facility                                 | Greater memory speed selection flexibility than               |
| <ul> <li>Each wait-state is 1/4 instruction cycle</li> </ul> | conventional full-cycle wait-states                           |
| - Two independent external memory speed                      | Allows mixing of slow and fast memory                         |
| partitions   | Optimizes system speed/cost requirements                      |

\* IEEE is a registered trademark of The Institute of Electrical and Electronics Engineers, Inc.

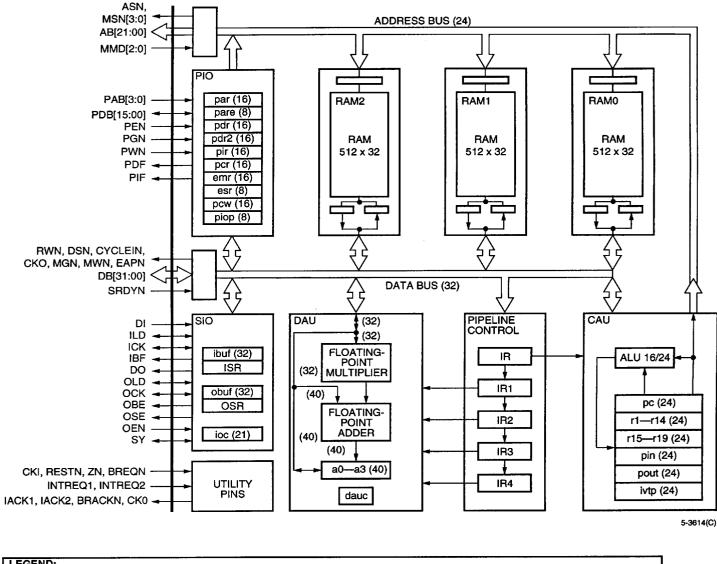
#### Table 3. DSP32C with External Memory Interface Device Speed Options

| Minimum Instruction<br>Cycle Time (ns) | Maximum Clock Frequency<br>(MHz) |
|--|----------------------------------|
| 50                                     | 80.000                           |
| 60                                     | 66.666                           |
| 80                                     | 50.000                           |

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### **Description** (continued)



| LEGENL |                               |         |                                |        |                            |
|--------|-------------------------------|---------|--------------------------------|--------|----------------------------|
| a0—a3  | Accumulators 0—3              | IR1—IR4 | Instruction register pipeline  | pdr    | PIO data register          |
| ALU    | Arithmetic logic unit         | ISR     | Input shift register           | pdr2   | PIO data register 2        |
| CAU    | Control arithmetic unit       | ivtp    | Interrupt vector table pointer | pin    | Serial DMA input pointer   |
| DAU    | Data arithmetic unit          | obuf    | Output buffer                  | PIO    | Parallel I/O unit          |
| dauc   | DAU control register          | OSR     | Output shift register          | piop   | Parallel I/O port register |
| emr    | Error mask register           | par     | PIO address register           | pir    | PIO interrupt register     |
| esr    | Error source register         | pare    | PIO address register extended  | pout   | Serial DMA output pointer  |
| ibuf   | Input buffer                  | pc      | Program counter                | r1—r19 | Registers 1—19             |
| ioc    | Input/output control register | pcr     | PIO control register           | RAM    | Read/write memory          |
| IR     | Instruction register          | pcw     | Processor control word         | SIO    | Serial I/O unit            |



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### AT&T DSP32C Digital Signal Processor with External Memory Interface

### Architecture

The DSP32C architecture is being used today to solve a wide variety of complex problems. A large set of general-purpose registers simplifies assembly-language programming and allows very efficient compiler implementations. Both internal and external memory are treated as a general resource allowing the programmer to freely mix both programs and/or data within the 16 Mbyte address space.

In addition to its powerful number-crunching capabilities and flexible memory organization, the DSP32C offers many features that allow it to be easily and quickly integrated into real world systems.

A block diagram of the DSP32C with External Memory Interface appears in Figure 1. The following subsections describe the components shown in this diagram.

### **Control Arithmetic Unit (CAU)**

The CAU generates memory addresses and performs 16- or 24-bit integer arithmetic at the rate of 20 million instructions per second. The CAU consists of a 24-bit arithmetic logic unit (ALU) which performs the integer arithmetic and logical operations, a 24-bit program counter (pc) register, and 22 general-purpose 24-bit registers. All 22 registers can be used for operands in the execution of 16- or 24-bit integer operations; however, some of these registers also serve special purposes. When addressing 32-bit floating-point operands, registers r1-r14 are used as memory pointers (rP), and r15-r19 are used as increment registers (rl). Register r20, also called pin, is used as the serial DMA input pointer. Register r21, also called pout, is used as the serial DMA output pointer. Register r22, also called interrupt vector table pointer (ivtp), is used as the base address for the interrupt vector table.

### Data Arithmetic Unit (DAU)

The DAU is configured for multiply/accumulate operations and is the primary execution unit for signal-processing algorithms. The DAU contains a floating-point multiplier and a floating-point adder, and four 40-bit accumulators (**a0**—**a3**). The multiplier and adder work in parallel to perform 20 million instructions per second of the form a = b + c \* d. The DAU multiplier operands (c and d) are 32-bit floating-point numbers (an 8-bit

exponent and a 24-bit mantissa) from memory or an accumulator. The multiplier always provides one 40-bit input to the adder. The other input can originate from memory, the I/O ports, or an accumulator. The operands for this second adder input can be 8-, 16-, 24-, 32-, or 40-bit numbers. The 40-bit operands (8-bit exponent, 24-bit mantissa, and eight mantissa guard bits) come from an accumulator (a0-a3). The 8-, 16-, and 24-bit operands are used in special function instructions whose purpose is data-type conversion. For either conversions or addition operations, 32-bit operands may come from memory or I/O registers. Available conversions are between the DSP32C floating-point format and the following: 8-, 16-, and 24-bit two's complement integer, µ-law, A-law, and single-precision IEEE floating-point format.

### **Internal and External Memory**

The DSP32C provides on-chip RAM and an external memory interface for off-chip ROM and/or RAM expansion. All memory can be addressed as 8-, 16-, 24-, or 32-bit words, with 32-bit data accessed at the same speed as 8-bit data. Instructions, tables, and data can be arbitrarily located in on-chip RAM or external memory. The addresses of the various blocks of memory can be configured in eight different memory modes. Four of the memory modes provide a DSP32-compatible 16-bit address space. The other four memory modes provide a full 24-bit address space. See the Memory Configuration section for more information on configuring the address space. Regardless of the configuration, the first instruction executed after reset is at address 0x000000.

Internally, the DSP32C device has 1,536 words of RAM which are available in all memory configurations. The on-chip RAM is static and does not need to be refreshed.

The external memory interface can directly address up to 16 Mbytes of additional memory. The interface supports wait-states and bus arbitration. The external memory is divided into two sections: a low partition (A) and a high partition (B). The number of wait-states for each partition is independently configurable (see Register Operation, Table 25, **pcw** Register). Therefore, a mix of slow and fast memories can be used to provide the necessary throughput at a reasonable cost.

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### Serial I/O Unit (SIO)

The serial I/O unit is used for serial-to-parallel conversion of input data and parallel-to-serial conversion of output data. SIO inputs are loaded into the input shift register (ISR) and then into the input buffer (**ibuf**). SIO outputs are loaded into the output buffer (**obuf**) and then into the output shift register (OSR). This doublebuffering makes back-to-back transfers possible, allowing the DSP32C program to begin a second transfer before the first has been completed. Data widths can be 8, 16, 24, or 32 bits. The input/output control (**ioc**) register in the SIO is used to select various I/O configurations, bit lengths, internal or external clocks, and internal or external synchronization (see Register Operation, Table 19, **ioc** Register).

### Parallel I/O Unit (PIO)

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The parallel I/O unit is an on-chip register file and bidirectional data bus that can be used for communication between the DSP32C device and an external device. The external PIO data bus can be 8 or 16 bits wide. PIO data transfers are made under program or DMA control. Using PIO DMA, an external device can download a program or data without interrupting execution of the DSP32C program. The PIO has three 16bit data registers (**pdr**, **pdr2**, and **pir**), a 24-bit address register (**par/pare**), a 16-bit processor control word (**pcw**), an 8-bit I/O port register (**piop**), a 16-bit control register (**pcr**), a 16-bit error mask register (**emr**), and an 8-bit error source register (**esr**). These registers are used to control PIO transfers and configure error control and interrupt features (see Register Operation).

### Memory Configuration

The addresses of the various blocks of memory can be configured in eight different memory modes. Four of the memory modes (0—3) provide a DSP32-compatible, 16-bit address space. The other four memory modes (4—7) provide a full 24-bit address space. Pin MMD2 selects either the DSP32 compatible 16-bit address space or the expanded 24-bit address space. Pins MMD0 and MMD1 select memory modes that determine the location of on-chip memory resources in the memory address space. Figure 2 shows the location of memory resources.

Memory accesses can be made without regard to the type or location of the physical memory; however, to achieve maximum throughput, instruction/data memory accesses of floating-point operations must alternate between physical memories. There are four physical memories: (1) RAM0, (2) RAM1, (3) external memory A and B, and (4) RAM2.

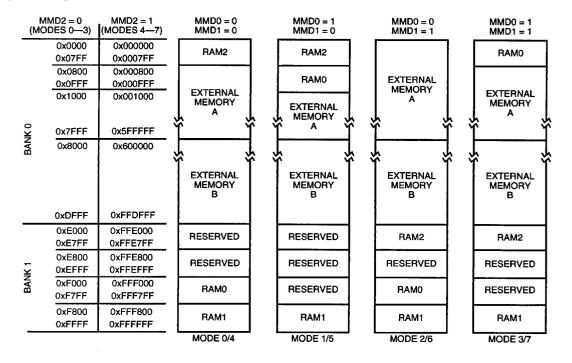
The number of wait-states for the external memory partitions A and B are independently configurable via the MEMA and MEMB fields of the **pcw** register. The number of wait-states may be statically configured or externally controlled. Statically configured waits of 1, 2, or 3 states allow the DSP32C to access memory without delays for handshaking (a state is one period of CKI, or 12.5 ns at maximum clock frequency). When configured for two or more externally controlled wait-states, the DSP32C generates wait-states until the memory acknowledges the transaction via the synchronous ready (SRDYN) handshaking signal.

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### Memory Configuration (continued)



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Figure 2. DSP32C Memory Configurations

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### **Memory Addressing**

Each 32-bit word is organized as 4 bytes, e.g., 3, 2, 1, 0, where byte 3 is the most significant byte (MSbyte) and byte 0 is the least significant byte (LSbyte) (see Table 4, Memory Addressing). A 16-bit integer is 2 bytes, either 1, 0 (with byte 1 the MSbyte and byte 0 the LSbyte) or 3, 2 (with byte 3 the MSbyte and byte 2 the LSbyte).

Integer operands of 24 bits are organized as 4 bytes. Byte 2 is the MSbyte, byte 0 is the LSbyte, and byte 3 is a sign extension of byte 2. Integer operands of 24 bits are addressed the same as 32-bit words. Memory address 0 can refer to an 8-bit byte (byte 0), a 16-bit integer (bytes 1, 0), a 24-bit integer (bytes 2, 1, 0), or a 32-bit word (bytes 3, 2, 1, 0).

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The external memory is accessed by a 22-bit external address bus (AB00—AB21) and four byte select lines (MSN0—MSN3) (see Table 5, Data Type Memory Select and Write Data). The bus obtains its data from the 22 most significant bits of the address bus and selects a 32-bit word in memory. The four byte select signals (active-low) select bytes within the 32-bit word (see Pin Information). The value of the byte select lines is determined by the two least significant bits of the address and the data type implied in the instruction. The address is specified either directly or via a register pointer (**pc**, **r1**—**r22**). With the maximum external memory attached, one can address a total of 16M bytes, 8M 16-bit integers, 4M 24-bit integers, or 4M 32-bit words.

| Table 4. | Memory | Addressing |
|----------|--------|------------|
|----------|--------|------------|

| 16-Bit | Memory<br>Address |      |      |   |
|--------|-------------------|------|------|---|
| Byte   | Byte              | Byte | Byte |   |
| 3      | 2                 | 1    | 0    | 0 |
| 7      | 6                 | 5    | 4    | 4 |
| 11     | 10                | 9    | 8    | 8 |
|        |                   | etc. |      |   |

#### Table 5. Data Type Memory Select and Write Data

| Data Type Memory Select |      |      |      |      | DSP32C V | Vrite Data* |      |     |
|-------------------------|------|------|------|------|----------|-------------|------|-----|
| Data Type               | MSN3 | MSN2 | MSN1 | MSNO | 24—31    | 16—23       | 8—15 | 0—7 |
| Byte 0                  | 1    | 1    | 1    | 0    | A        | A           | А    | Α   |
| Byte 1                  | 1    | 1    | 0    | 1    | В        | В           | В    | в   |
| Byte 2                  | 1    | 0    | 1    | 1    | С        | С           | С    | С   |
| Byte 3                  | 0    | 1    | 1    | 1    | D        | D           | D    | D   |
| Low 16-bit              | 1    | 1    | 0    | 0    | В        | A           | В    | Α   |
| High 16-bit             | 0    | 0    | 1    | 1    | D        | С           | D    | С   |
| 32-bit/24-bit           | 0    | 0    | 0    | 0    | D        | С           | В    | A   |

\* A = write data DB00—DB07; B = write data DB08—DB15; C = write data DB16—DB23; D = write data DB24—DB31.

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### **Interrupt Operation**

The DSP32C provides a single-level interrupt facility with six sources (four internal and two external). The interrupts are prioritized and are individually maskable via the INTER field of the **pcw** register. The sources are described below in descending priority:

- 1. External Interrupt One (INTREQ1) level sensitive.
- 2. Parallel Buffer Full (PDF) generated when the **pdr** register is loaded.
- 3. Parallel Buffer Empty (PDE) generated when the **pdr** register is read.
- 4. SIO Input Buffer Full (IBF) generated when the IBF flag is set.
- 5. SIO Output Buffer Empty (OBE) generated when the OBE flag is set.
- External Interrupt Two (INTREQ2) level sensitive.

Before servicing an interrupt, the DSP32C saves the state of the machine that is invisible to the programmer, as well as DAU accumulators **a0---a3** and the dauc register. Internal states that are visible to the programmer and need to be saved, except a0-a3 and the **dauc**, must be saved and restored by the interrupt service routine. In response to a given interrupt, the DSP32C branches to the corresponding address in the interrupt vector table. The interrupt vector table contains six pairs of 32-bit words starting at the location specified in the interrupt vector table pointer register ivtp (r22). Each pair of words in the table should contain an unconditional branch to the appropriate interrupt routine. Note that even when masked, the interrupt conditions may be tested in conditional branch instructions (see Instruction Set). Figure 3 is a memory map of the interrupt vector table. To return to the interrupted program, the user should restore the user-visible state of the DSP32C (which was saved), and then execute the ireturn instruction. The latter operation restores **a0—a3** and the state of the machine that is not visible to the user.

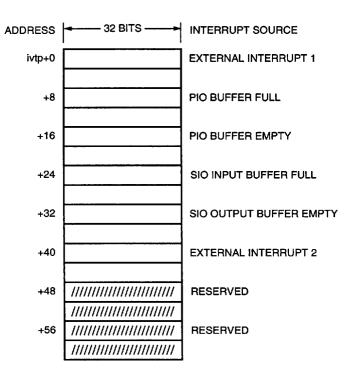


Figure 3. Interrupt Vector Table

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### **Instruction Set**

#### Table 6. Features and Benefits of the DSP32C Instruction Set

| Features   | Benefits  |
|--|---|
| Instruction started every instruction cycle                                    | Allows more complex or a greater number of applica-<br>tions to be implemented  |
| Full set of microprocessor-like instructions                                   | Expands the number of applications that can be effi-<br>ciently handled   |
| Conditional branches   | Simplifies programming task*  |
| Conditional ALU operations   | Permits very fast, efficient coding*<br>Eliminates unnecessary branch instructions  |
| Single-cycle <b>pc-</b> relative addressing for position-inde-<br>pendent code | Simplifies multitask applications*  |
| Data stationary coding   | Enables parallel operation of arithmetic and logical<br>operations<br>Allows efficient compiler implementations*<br>Provides automatic pipeline control*<br>Simplifies program development process* |

\* Provides faster time to market.

The DSP32C assembly language frees programmers from tedious memorization of assembly-language mnemonics. Instructions in the DSP32C are patterned after the C programming language and are entered in a natural equation syntax. In addition to being easier to learn, the resulting code is far more readable than mnemonic-based assembly languages, making code maintenance much easier.

Assembly-language example (32-bit multiply/ accumulate with store to memory):

\*r1++ = a0 = a1 + \*r2++ \* \*r3++

The execution of this instruction simply follows the conventions of the high-level C programming language:

"Multiply the 32-bit floating-point values stored in the memory locations pointed to by registers **r2** and **r3**. Add the result to the contents of accumulator **a1**, store the result in accumulator **a0**, and write the result to the 32-bit memory location pointed to by register **r1**. Post-increment pointer registers **r1**, **r2**, and **r3**." The DSP32C has two general types of instructions that correspond to the two execution units: data arithmetic (DA) instructions and control arithmetic (CA) instructions.

Primarily, DA instructions perform 32-bit floating-point multiply/accumulate operations for signal processing algorithms. Other DA instructions convert the DSP32C's internal floating-point data to and from each of the following types: 8-bit, 16-bit, or 24-bit 2's complement integer; µ-law; A-law; or single-precision *IEEE* floating-point.

The CA instructions perform microprocessor operations such as 16-bit and 24-bit integer arithmetic and logic functions, conditional branching, and moving data.

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#### Flags

The DSP32C has internal flags that are affected by the results of certain DA, CA, or I/O instructions and certain I/O events. These flags, although not directly visible to the user, may be tested by conditional instructions. Table 7 lists the flags and their meanings.

#### Table 7. DSP32C Flags

|      | DAU Flags                        |   |  |  |
|------|----------------------------------|---|--|--|
| Flag | Meaning (Flag = 1)               | Description   |  |  |
| N    | Result is negative               | Sign bit = 1.   |  |  |
| Z    | Result is zero                   | All 40 bits of accumulator = 0.   |  |  |
| V    | Result overflowed*               | DAU result   > 3.40282 E 38.  |  |  |
| U    | Result underflowed*              | DAU result   < 5.87747 E -39.   |  |  |
|      |                                  | CAU Flags   |  |  |
| n    | Result is negative               | (16-bit) n = b23 (bit 23 of ALU result).<br>(24-bit) n = b23.                                     |  |  |
| z    | Result is zero                   | (16-bit) $z = \overline{b23+b22+b1+b0}$ (+ = OR).<br>(24-bit) $z = \overline{b23+b22+b1+b0}$ .    |  |  |
| с    | Carry or borrow out of MSB       | (16-bit) $c = b15c$ (carry out of ALU bit 15).<br>(24-bit) $c = b23c$ .                           |  |  |
| v    | Result overflowed                | (16-bit) $v = b14c \land b15c$ ( $^{\circ} = exclusive OR$ ).<br>(24-bit) $v = b22c \land b23c$ . |  |  |
|      |                                  | I/O Flags   |  |  |
| i    | Serial input buffer full         | Pin IBF = 1.  |  |  |
| 0    | Serial output buffer full        | Pin OBE = 0.  |  |  |
| р    | Parallel data register full      | Pin PDF = 1.  |  |  |
| P    | Parallel interrupt register full | Pin PIF = 1.  |  |  |
| S    | SY (I/O sync) set (1)            | Pin SY = 1.   |  |  |
| b    | Serial I/O frame boundary        | fbs = 1.  |  |  |
| r    | Interrupt pin 1 high (1)         | Pin INTREQ1 = 1.  |  |  |
| R    | Interrupt pin 2 high (1)         | Pin INTREQ2 = 1.  |  |  |

The DSP3207 Digital Signal Processor Information Manual dated July 1994, Section 3.3.3, contains a detailed description of the floating-point formats and exceptions. The DSP3207 floating-point format and arithmetic is identical to that of the DSP32C.

DSP32C instructions and the flags affected by each instruction are specified in the following tables. A zero (0) shown in place of a flag means that the flag is always made zero; a dash (—) in place of a flag means that the flag is unaffected by the instruction.

The complete DSP32C instruction set, grouped as DA and CA instructions, follows. Where braces, { }, are shown in an instruction, one of the enclosed items must be chosen. Items enclosed in brackets, [ ], are optional.

**Note:** { } and [ ] are not part of the instruction syntax. Parentheses, ( ), are part of the syntax and must appear where shown in an instruction. Lower-case letters are part of the syntax and upper-case letters are replaced by immediate data or by a register name (see tables following each instruction group).

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### **Data Arithmetic (DA) Instructions**

The DA instructions are divided into two functional groups: multiply/accumulate and special functions.

| Table 8. | Data | Multiply/Accumulate | Instructions |
|----------|------|---------------------|--------------|
|----------|------|---------------------|--------------|

| Instruction               | DAU Flags<br>Affected | Description  |
|---------------------------|-----------------------|--|
| [Z=] aN = [–]aM {+,–} Y*X | NZVU                  | The product of the X and Y fields is added to or subtracted from<br>the accumulator <b>aM</b> (or its negative), and the result is stored in<br>accumulator <b>aN</b> . The result can also be output according to the<br>Z field. |
| aN = [-]aM {+,-} (Z=Y)*X  | NZVU                  | The Y field operand is output according to the Z field. The product of the X and Y fields is added to or subtracted from the accumulator <b>aM</b> (or its negative), and the sum is stored in accumulator <b>aN</b> .             |
| [Z=] aN = [–]Y {+,−} aM*X | NZVU                  | The product of the X field and the accumulator <b>aM</b> is added to<br>or subtracted from the Y field (or its negative). The result is<br>placed in accumulator <b>aN</b> and can also be output according to<br>the Z field.     |
| [Z=] aN = [−]Y*X          | NZVU                  | The product of the X and Y fields is added to or subtracted from zero. The result is stored in accumulator <b>aN</b> and can also be output according to the Z field.  |
| aN = [-](Z=Y)*X           | NZVU                  | The value of the Y field is output according to the Z field. The product of the Y and X fields (or the negative of the product) is stored in accumulator <b>aN</b> .   |
| [Z=] aN = [-]Y {+,-}X     | NZVU                  | The sum or difference of the Y and X fields is stored in accumulator $aN$ , and the result can also be output according to the Z field. Note that X is a multiplier input.   |
| [Z=] aN = [-]Y            | NZVU                  | The value of the <b>Y</b> field (or its negative) is placed in accumula-<br>tor <b>aN</b> and can also be output according to the <b>Z</b> field.  |
| aN = [-](Z=Y) {+,-} X     | NZVU                  | The sum or difference of the Y and X fields is stored in accumu-<br>lator <b>aN</b> , and Y can also be output according to the Z field.   |

#### Table 9. Replacement Table for DA Multiply/Accumulate Instructions

| Replace | Value <sup>†</sup>                                   | Description   |  |  |
|---------|--|---|--|--|
| aN, aM  | a0—a3  | One of the four DAU accumulators.   |  |  |
| Х, Ү    | *rP, *rP++, *rP, *rP++rl<br>a0—a3<br>ibuf            | 32-bit memory location.<br>One of the four DAU accumulators.<br>SIO input buffer.   |  |  |
| Z       | *rP, *rP++, *rP,<br>*rP++rl, *rP++rlr<br>obuf<br>pdr | 32-bit memory location.<br><b>rlr</b> indicates carry reverse add.<br>SIO output buffer.<br>PIO data register ( <b>pdr</b> concatenated with <b>pdr2</b> ). |  |  |

t rP refers to r1-r14 and is used as a memory pointer. rI refers to r15-r19 and is used as an increment pointer.

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### Data Arithmetic (DA) Instructions (continued)

| Instruction          | DAU Flags<br>Affected | Description   |
|----------------------|-----------------------|---|
| [Z=] aN = ic(Y)      | NZ00                  | Input conversion, μ-law, A-law, 8-bit linear to float.                      |
| [Z=] aN = oc(Y)      |                       | Output conversion, float to $\mu$ -law, A-law, 8-bit linear (see Table 20). |
| [Z=] aN = float(Y)   | NZ00                  | 16-bit integer to float.  |
| [Z=] aN = float24(Y) | NZ00                  | 24-bit integer to float.  |
| [Z=] aN = int(Y)     | —                     | Float to 16-bit integer (round or truncate, dauc[4]).                       |
| [Z=] aN = int24(Y)   | _                     | Float to 24-bit integer (round or truncate, dauc[4]).                       |
| [Z=] aN = round(Y)   | NZVU*                 | Round float (40-bit) to float (32-bit).                                     |
| [Z=] aN = ifalt(Y)   | —                     | If $(aN < 0)$ then $[Z =] aN = Y$ else $[Z =] aN$ .                         |
| [Z=] aN = ifaeq(Y)   |                       | If $(aN = 0)$ then $[Z =] aN = Y$ else $[Z =] aN$ .                         |
| [Z=] aN = ifagt(Y)   |                       | If $(aN > 0)$ then $[Z =] aN = Y$ else $[Z =] aN$ .                         |
| [Z=] aN = dsp(Y)     | NZVU*                 | IEEE-to-DSP32 format conversion.  |
| [Z=] aN = ieee(Y)    |                       | DSP32-to-IEEE format conversion.  |
| [Z=] aN = seed(Y)    | NZ0U*                 | 32-bit to 32-bit reciprocal program seed.                                   |

#### **Table 10. DA Special Function Instructions**

The DSP3207 Digital Signal Processor Information Manual dated July 1994 contains detailed descriptions of underflow and overflow for the **round**, **dsp**, and **seed** instructions. These descriptions can be found in the detailed descriptions of each instruction in Section 4.7 of the manual. The DSP3207 floating-point format, arithmetic, and the **round**, **dsp**, and **seed** instructions are identical to the DSP32C.

| Replace | Value <sup>†</sup>       | Description                                     |  |  |
|---------|--------------------------|---|--|--|
| aN      | a0—a3                    | One of the four DAU accumulators.               |  |  |
| Υ‡      | *rP, *rP++, *rP, *rP++rl | 32-bit memory location.                         |  |  |
|         | a0—a3                    | One of the four DAU accumulators.               |  |  |
|         | ibuf                     | SIO input buffer.                               |  |  |
|         | pdr                      | PIO data register (pdr).                        |  |  |
| Z       | *rP, *rP++, *rP, *rP++rl | 32-bit memory location.                         |  |  |
|         | obuf                     | SIO output buffer.                              |  |  |
|         | pdr                      | PIO data register (pdr concatenated with pdr2). |  |  |

† rP refers to r1—r14 and is used as a memory pointer. rl refers to r15—r19 and is used as an increment pointer.
 ‡ Y may not be a0—a3 for the float or dsp special functions.

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### **Control Arithmetic (CA) Instructions**

#### Table 12. CA Control Instructions

| Instruction                      | Flags<br>Affected | Instruction<br>Format | Description  |
|----------------------------------|-------------------|-----------------------|--|
| if (CA COND) goto {rH, N, rH+N,} | None              | 0                     | Conditional branch.  |
| if (rM>= 0) goto {rH, N, rH+N,}  |                   | 3a                    | Conditional branch.  |
| if (DA COND) goto {rH, N, rH+N,} |                   | 0                     | Conditional branch.  |
| if (IO COND) goto {rH, N, rH+N,} |                   | 0                     | Conditional branch.  |
| call {rH, N, M, rH+N,} (rM)      |                   | 4                     | Call subroutine.   |
| return (rM)                      |                   | 0                     | Return from subroutine.  |
| ireturn                          |                   | 0                     | Return from interrupt.   |
| do J,{K,rH}                      |                   | 3b, 3c                | Do next J + 1 instructions.<br>K + 1 (or rH + 1) times.<br>J = 0, 1, 2 31.<br>K = rH = 0, 1, 2 2047. |
| goto {rH, N, M, rH+N}            |                   | 0                     | Unconditional branch.  |
| nop                              |                   | 0                     | No operation.  |

Notes: The **do** instruction and the instructions it encompasses are not interruptible, except for the last instruction during the last iteration. Further, the **do** instruction cannot be used in an interrupt routine.

A do loop should not contain any goto or call instructions. The assembler does not issue any warnings or errors if this is attempted.

| Value | CAU Flags*             | Description                     |
|-------|------------------------|---------------------------------|
| pl    | n = 0                  | Result is nonnegative (plus).   |
| mi    | n = 1                  | Result is negative (minus).     |
| ne    | z = 0                  | Result not equal to zero.       |
| eq    | z = 1                  | Result equal to zero.           |
| vc    | v = 0                  | Overflow clear, no overflow.    |
| vs    | v = 1                  | Overflow set, overflowed.       |
| СС    | c = 0                  | Carry clear, no carry.          |
| cs    | c = 1                  | Carry set, carry.               |
| ge    | n ^ v = 0              | Greater than or equal to.       |
| lt    | n ^ v = 1              | Less than.                      |
| gt    | $z   (n \wedge v) = 0$ | Greater than.                   |
| le    | z I (n ^ v) = 1        | Less than or equal to.          |
| hi    | c   z = 0              | Greater than (unsigned number). |
| ls    | c   z = 1              | Less than (unsigned number).    |

\* Symbol interpretation:  $^ = XOR$ ; | = OR.

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### Control Arithmetic (CA) Instructions (continued)

### Table 14. Replacement Table for CA Control Group Instructions, DA Conditions (DA COND)

| Value | DAU Flags | Description                    |  |
|-------|-----------|--------------------------------|--|
| ane   | Z = 0     | Not equal to zero.             |  |
| aeq   | Z = 1     | Equal to zero.                 |  |
| age   | N = 0     | Greater than or equal to zero. |  |
| alt   | N = 1     | Less than zero.                |  |
| avc   | V = 0     | Overflow clear, no overflow.   |  |
| avs   | V = 1     | Overflow set, overflowed.      |  |
| auc   | U = 0     | Underflow clear, no underflow. |  |
| aus   | U = 1     | Underflow set, underflowed.    |  |
| agt   | N I Z = 0 | Greater than zero.             |  |
| ale   | N   Z = 1 | Less than or equal to zero.    |  |

| Mnemonic | Condition | Description                        |  |  |
|----------|-----------|------------------------------------|--|--|
| ibe      | ibf = 0   | Input buffer empty.                |  |  |
| ibf      | ibf = 1   | Input buffer full.                 |  |  |
| obe      | obe = 1   | Output buffer empty.               |  |  |
| obf      | obe = 0   | Output buffer full.                |  |  |
| pde      | pdf = 0   | Parallel data register empty.      |  |  |
| pdf      | pdf = 1   | Parallel data register full.       |  |  |
| pie      | pif = 0   | Parallel interrupt register empty. |  |  |
| pif      | pif = 1   | Parallel interrupt register full.  |  |  |
| syc      | sy = 0    | Sync signal low.                   |  |  |
| sys      | sy = 1    | Sync signal high.                  |  |  |
| fbc      | fb = 0    | Serial frame boundary clear.       |  |  |
| fbs      | fb = 1    | Serial frame boundary set.         |  |  |
| ireq1_hi | ireq1 = 1 | INTREQ1 pin is deasserted (1).     |  |  |
| ireq1_lo | ireq1 = 0 | INTREQ1 pin is asserted (0).       |  |  |
| ireq2_hi | ireq2 = 1 | INTREQ2 pin is deasserted (1).     |  |  |
| ireq2_lo | ireq2 = 0 | INTREQ2 pin is asserted (0).       |  |  |

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### Control Arithmetic (CA) Instructions (continued)

#### Table 16. CA Arithmetic/Logic Instructions

| Instruction            | CAU Flags<br>Affected | Instruction<br>Format | Description  |
|------------------------|-----------------------|-----------------------|--|
| rD[e] = rH + N         | nzvc                  | 5a, 5b                | Three operand add with 16-bit sign extended immediate. |
| rD[e] = rS1 + rS2      | nzvc                  | 6a, 6b                | Triadic add.   |
| rD[e] = rD + rS        | nzvc                  | 6a, 6b                | Dyadic add.  |
| rD[e] = rS1 – rS2      | nzvc                  | 6a, 6b                | Triadic left subtract.                                 |
| rD[e] = rS2 - rS1      | nzvc                  | 6a, 6b                | Triadic right subtract.                                |
| $rD[e] = rD - {N, rS}$ | nzvc                  | 6a, 6b, 6c, 6d        | Right subtract.  |
| rD[e] - {N, rS}        | nzvc                  | 6a, 6b, 6c, 6d        | Compare.   |
| rD[e] = {N, rS} – rD   | nzvc                  | 6a, 6b, 6c, 6d        | Left subtract.   |
| rD[e] = rD & {N, rS}   | nz00                  | 6a, 6b, 6c, 6d        | AND.   |
| rD[e] = rS1 & rS2      | nz00                  | 6a, 6b                | Triadic AND.   |
| rD[e] & {N, rS}        | nz00                  | 6a, 6b, 6c, 6d        | Bit test.  |
| rD[e] = rD I {N, rS}   | nz00                  | 6a, 6b, 6c, 6d        | OR.  |
| rD[e] = rS1   rS2      | nz00                  | 6a, 6b                | Triadic OR.  |
| rD[e] = rD ^ {N, rS}   | nz00                  | 6a, 6b, 6c, 6d        | XOR.   |
| rD[e] = rS1 ^ rS2      | nz00                  | 6a, 6b                | Triadic XOR.   |
| rD[e] = rS / 2         | nz0c                  | 6a, 6b                | Arithmetic right shift.                                |
| rD[e] = rS >> 1        | 0z0c                  | 6a, 6b                | Logical right shift.                                   |
| rD[e] = rS >>> 1       | nz0c                  | 6a, 6b                | Rotate right through carry.                            |
| rD[e] = rS <<< 1       | nzvc                  | 6a, 6b                | Rotate left through carry.                             |
| rD[e] =rS              | nzvc                  | 6a, 6b                | Negate.  |
| rD[e] = rS * 2         | nzvc                  | 6a, 6b                | Arithmetic left shift.                                 |
| rD[e] = rD # {N, rS}   | nz0c                  | 6a, 6b, 6c, 6d        | Dyadic carry reverse add.                              |
| rD[e] = rS1 # rS2      | nz0c                  | 6a, 6b                | Triadic carry reverse add.                             |
| rD[e] = rD &~ {N, rS}  | nzvc                  | 6a, 6b, 6c, 6d        | Dyadic AND with complement.                            |
| rD[e] = rS1 &~ rS2     | nzvc                  | 6a, 6b                | Triadic AND with complement.                           |
| rD[e] = rS             | nzvc                  | 6a, 6b                | Assignment.  |
| rD[e] = rS {+,-} 1     | nzvc                  | 6a, 6b                | Increment/decrement.                                   |

Except for instructions with immediate operands (N), all CA arithmetic/logic instructions above may also be conditionally executed on the basis of CA conditions. The syntax is as follows:

#### if (CA COND) instruction

The optional e suffix is for 24-bit (extended) operands. Flags are set according to the rules for 24-bit operands. N is always 16 bits, and bit 15 is extended to 24 bits, for 24-bit operations.

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### Control Arithmetic (CA) Instructions (continued)

#### **Table 17. CA Data Move Instructions**

| Instruction  | CAU Flags<br>Affected | Format | Description                         |
|--|-----------------------|--------|-------------------------------------|
| rD = N   | nz00                  | 6c     | 16-bit immediate load.              |
| rDe = M  | —                     | 8b     | 24-bit immediate load.              |
| {ioc <sup>†</sup> , dauc} = VALUE                      | —                     | 5a     | 5- or 21-bit immediate load.        |
| $\{MEM, *N, obuf, piop\} = \{rSh, rSl\}$               | _                     | 7      | MEM, *N, piop, and obuf are 8 bits. |
| {MEM, *N, obuf, pdr, pdr2, pir, pcw} = rS, pcsh        |                       | 7      | MEM, *N, and obuf are 16 bits.      |
| {MEM, *N, obuf} = rSe, pcshe                           | —                     | 7      | MEM, *N, and obuf are 24 bits.      |
| {rDh, rDl} = {MEM, *N, ibuf, piop}                     | nz00                  | 7      | MEM, *N, piop, and ibuf are 8 bits. |
| rD = {MEM, *N, ibuf, pdr, pdr2, pir, pcw} <sup>‡</sup> | nz00                  | 7      | MEM, *N, and ibuf are 16 bits.      |
| rDe = {MEM, *N, ibuf}                                  | nz00                  | 7      | MEM, *N, and ibuf are 24 bits.      |
| MEM = {ibufl, piop}                                    |                       | 7      | 8-bit transfer.                     |
| MEM = {ibuf, pdr, pdr2, pir, pcw}§                     |                       | 7      | 16-bit transfer.                    |
| MEM = {ibufe, pdre}§                                   | —                     | 7      | 32-bit transfer.                    |
| {obufl, piop} = MEM                                    |                       | 7      | 8-bit transfer.                     |
| {obuf, pdr, pdr2, pir, pcw} = MEM                      |                       | 7      | 16-bit transfer.                    |
| {obufe, pdre} = MEM                                    | _                     | 7      | 32-bit transfer.                    |

<sup>†</sup> **ioc** = **VALUE** may not be used in an interrupt routine.

<sup>‡</sup> rD = {pdr, pdr2, pir, pcw} cannot be used in the presence of 32-bit PIO DMA.
 <sup>§</sup> MEM = {pdr, pdr2, pir, pcw, pdre} cannot be used in the presence of PIO DMA.

#### Table 18. Replacement Table for All CA Instructions

| Replace    | Value                                      | Description   |
|------------|--|---|
| rH         | pc, r1—r22                                 | One of 22 general-purpose registers, or the program counter.  |
| rM, rS, rD | r1—r22                                     | One of 22 CAU registers.  |
| rDh, rSh   | r1—r22                                     | High-order bits 8—15 are moved. The low-order bits 0—7 are cleared for <b>rD</b> and remain unchanged for <b>rS</b> . |
| rDl, rSl   | r1—r22                                     | Low-order bits 0—7 are moved. The high-order bits are cleared for <b>rD</b> and remain unchanged for <b>rS</b> .      |
| MEM        | *rP, *rP++, *rP,<br>*rP++rl, (P, I = 1—22) | 32-bit, 16-bit, or 8-bit memory location.   |
| N          | 16-bit number                              | Two's complement integer.   |
| М          | 24-bit number                              | Two's complement integer.   |
| VALUE      | 21-bit number or<br>5-bit number           | VALUE is a 21-bit value for the <b>ioc</b> word and a 5-bit value for the <b>dauc</b> word.                           |

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### **Instruction Encoding**

The following sections specify the device level encoding of the DSP32C instruction set.

### **DA Instruction Formats**

### Format 1. [Z=] aN = {+,-} Y {+,-} aM \* X

| Bit   | 31 | 30 | 29 | 28 | 27 | 26 | 25 | 24 | 23 | 22 | 21 | 20—14 | 13—7 | 60 |
|-------|----|----|----|----|----|----|----|----|----|----|----|-------|------|----|
| Field | 0  | 0  | 1  |    | М  |    | r  | F  | S  | 1  | N  | Х     | Y    | Z  |

### Format 2. $aN = \{+,-\} aM \{+,-\} (Z=Y) * X$

| Bit   | 31 | 30 | 29 | 28 <sup>·</sup> | 27 | 26 | 25 | 24 | 23 | 22 | 21 | 20—14 | 13—7 | 6—0 |
|-------|----|----|----|-----------------|----|----|----|----|----|----|----|-------|------|-----|
| Field | 0  | 1  | 0  |                 | М  |    | r  | F  | S  | 1  | N  | X     | Y    | Z   |

#### **Format 3.** [Z=] $aN = \{+,-\} aM \{+,-\} Y * X$

| Bit   | 31 | 30 | 29 | 28 | 27 | 26 | 25 | 24 | 23 | 22 | 21 | 20—14 | 13—7 | 60 |
|-------|----|----|----|----|----|----|----|----|----|----|----|-------|------|----|
| Field | 0  | 1  | 1  |    | М  |    | r  | F  | S  | 1  | 1  | Х     | Υ    | Z  |

### Format 4. $aN = \{+,-\} (Z = Y) \{+,-\} X$

| Bit   | 31 | 30 | 29 | 28 | 27 | 26 | 25 | 24 | 23 | 22 | 21 | 20—14 | 13—7 | 6—0 |
|-------|----|----|----|----|----|----|----|----|----|----|----|-------|------|-----|
| Field | 0  | 0  | 1  | 1  | 1  | 0  | r  | F  | S  | 1  | N  | Х     | Y    | Z   |

#### Format 5. Special Function Instructions

| Bit   | 31 | 30 | 29 | 28 | 27 | 26—23 | 22 | 21 | 20—14   | 13—7 | 6—0 |
|-------|----|----|----|----|----|-------|----|----|---------|------|-----|
| Field | 0  | 1  | 1  | 1  | 1  | G     | 1  |    | 0000000 | Y    | z   |

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### **Encoding for DA Instruction Formats**

G Field. Specifies a data-type conversion operation.

| G    | Operation                  |
|------|----------------------------|
| 0000 | ic (input conversion)      |
| 0001 | oc (output conversion)     |
| 0010 | float                      |
| 0011 | int                        |
| 0100 | round                      |
| 0101 | ifalt                      |
| 0110 | ifaeq                      |
| 0111 | ifagt                      |
| 1000 | Reserved                   |
| 1001 | Reserved                   |
| 1010 | float24                    |
| 1011 | int24                      |
| 1100 | ieee (convert DSP to IEEE) |
| 1101 | dsp (convert IEEE to DSP)  |
| 1110 | seed                       |
| 1111 | Reserved                   |

**M Field.** Specifies the accumulator used or a constant value.

| М   | Operation                       |
|-----|---------------------------------|
| 000 | a0                              |
| 001 | a1                              |
| 010 | a2                              |
| 011 | a3                              |
| 100 | 0.0                             |
| 101 | 1.0                             |
| 110 | Specifies Format 4 DAU instruc- |
|     | tion                            |
| 111 | Reserved                        |

F Field. Specifies sign of operation (adder input).

| F | Operation |
|---|-----------|
| 0 | +         |
| 1 | _         |

S Field. Specifies sign of operation (product).

| S | Operation |
|---|-----------|
| 0 | +         |
| 1 | -         |

**r Field.** Specifies bit-reversed addressing mode (carry-reverse add with register).

| r | Operation       |
|---|-----------------|
| 0 | Nonbit-reversed |
| 1 | Bit-reversed    |

**X, Y, Z Fields.** These fields indicate register direct or register indirect modes. The 7-bit fields are divided into two subfields, p and i (ppppiii). Bits 0—2 of the 7-bit field are labeled i. The i subfield specifies an rl register in the CAU. Bits 3—6 are labeled p. The p field specifies an rP register in the CAU.

**p Field.** Specifies register indirect: \*rP, \*rP++, \*rP--, \*rP++rI, \*rP++rIr.

| р    | Operation                            |
|------|--------------------------------------|
| 0000 | Selects register direct <sup>†</sup> |
| 0001 | r1                                   |
| 0010 | r2                                   |
| 0011 | r3                                   |
| 0100 | r4                                   |
| 0101 | r5                                   |
| 0110 | r6                                   |
| 0111 | r7                                   |
| 1000 | r8                                   |
| 1001 | r9                                   |
| 1010 | r10                                  |
| 1011 | r11                                  |
| 1100 | r12                                  |
| 1101 | r13                                  |
| 1110 | r14                                  |
| 1111 | Not allowed                          |

† See i field (p = 0000).

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Encoding for DA Instruction Formats (continued)

N Field. Specifies the accumulator used.

| Ν  | Operation |
|----|-----------|
| 00 | a0        |
| 01 | a1        |
| 10 | a2        |
| 11 | a3        |

**i Field (p**  $\neq$  **0000).** Specifies register-indirect: rl, rP++rl.

| i   | Operation (p ≠ 0000) |
|-----|----------------------|
| 000 | 0                    |
| 001 | r15                  |
| 010 | r16                  |
| 011 | r17                  |
| 100 | r18                  |
| 101 | r19                  |
| 110 | -4(f), -2(i), -1(b)  |
| 111 | +4(f), +2(i), +1(b)  |

**i Field (p = 0000).** Specifies a register-direct operation: REG. This is a special case of the i field (when p field equals zero).

| i   | Operation (p = 0000)    |
|-----|-------------------------|
| 000 | a0 – X, Y fields only   |
| 001 | a1 – X, Y fields only   |
| 010 | a2 – X, Y fields only   |
| 011 | a3 – X, Y fields only   |
| 100 | ibuf – X, Y fields only |
| 101 | obuf – Z field only     |
| 110 | pdr – Y, Z fields       |
| 111 | No write, Z field only  |

### CA Instruction Formats (Eight Format Groups)

Refer to CAU Encoding for CA Instruction Formats for an explanation of each field, except where actual bit values (0, 1) are given.

Formats 0 and 1. Conditional Branch: 24-Bit Register-Indirect with 16-Bit Sign-Extended Offset.

| Bit   | 31 | 30 | 29 | 28 | 27 | 26—22 | 21 | 20—16 | 15—0 |
|-------|----|----|----|----|----|-------|----|-------|------|
| Field | 0  | 0  | 0  | 0  | 0  | С     | G  | н     | N    |

For **ireturn** instruction, C = 00000, G = 1, H = pcsh = 11110, N = 0. For **nop** instruction, C = 00000, G = 0, H = 00000, N = 0.

#### Format 2. Reserved

| Bit   | 31 | 30 | 29 | 28 | 27 | 26 | 25—20 | 19—15 | 1410 | 9—5 | 4—0 |
|-------|----|----|----|----|----|----|-------|-------|------|-----|-----|
| Field | 0  | 0  | 0  | 0  | 1  | 0  | —     |       |      |     | —   |

#### Format 3a. Loop Counter

| Bit   | 31 | 30 | 29 | 28 | 27 | 26 | 25—21 | 20—16 | 15—0 |
|-------|----|----|----|----|----|----|-------|-------|------|
| Field | 0  | 0  | 0  | 0  | 1  | 1  | М     | Н     | N    |

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### CA Instruction Formats (Eight Format Groups) (continued)

#### Format 3b. Do Instruction (Immediate)

| Bit   | 31 | 30 | 29 | 28 | 27 | 26 | 25—21 | 20—16 | 15—11 | 100 |
|-------|----|----|----|----|----|----|-------|-------|-------|-----|
| Field | 1  | 0  | 0  | 0  | 1  | 1  | 00000 | J     | 00000 | к   |

#### Format 3c. Do Instruction (Register)

| Bit   | 31 | 30 | 29 | 28 | 27 | 26 | 25—21 | 20—16 | 15—5        | 4-0 |
|-------|----|----|----|----|----|----|-------|-------|-------------|-----|
| Field | 1  | 0  | 0  | 0  | 1  | 1  | 00001 | J     | 00000000000 | н   |

#### Format 4. Call: 24-Bit Register-Indirect with 16-Bit Immediate Offset

| Bit   | 31 | 30 | 29 | 28 | 27 | 26 | 25—21 | 20—16 | 15—0 |
|-------|----|----|----|----|----|----|-------|-------|------|
| Field | 0  | 0  | 0  | 1  | 0  | 0  | М     | Н     | N    |

#### Format 5a. 16-Bit Three Operand Add

| Bit   | 31 | 30 | 29 | 28 | 27 | 26 | 25—21 | 20—16 | 15—0 |
|-------|----|----|----|----|----|----|-------|-------|------|
| Field | 0  | 0  | 0  | 1  | 0  | 1  | D     | н     | N    |

#### Format 5b. 24-Bit Three Operand Add with 16-Bit Sign-Extended Immediate

| Bit   | 31 | 30 | 29 | 28 | 27 | 26 | 25—21 | 20—16 | 150 |
|-------|----|----|----|----|----|----|-------|-------|-----|
| Field | 1  | 0  | 0  | 1  | 0  | 1  | D     | н     | N   |

#### Format 6a. 16-Bit Arithmetic/Logic Group — Register Source

| Bit   | 31 | 30 | 29 | 28 | 27 | 26 | 25 | 24—21 | 20—16 | 15—13 | 12 | 11 | 10 | 9—5 | 40 |
|-------|----|----|----|----|----|----|----|-------|-------|-------|----|----|----|-----|----|
| Field | 0  | 0  | 0  | 1  | 1  | 0  | 0  | F     | D     | C*    | G  | Е  | к  | S1  | S2 |

\* Three least significant bits of the C field (CA conditions only).

#### Format 6b. 24-Bit Arithmetic/Logic Group — Register Source

| Bit   | 31 | 30 | 29 | 28 | 27 | 26 | 25 | 24—21 | 20—16 | 15—13 | 12 | 11 | 10 | 95 | 4—0 |
|-------|----|----|----|----|----|----|----|-------|-------|-------|----|----|----|----|-----|
| Field | 1  | 0  | 0  | 1  | 1  | 0  | 0  | F     | D     | C*    | G  | E  | к  | S1 | S2  |

\* Three least significant bits of the C field (CA conditions only).

#### Format 6c. 16-Bit Arithmetic/Logic Group — Immediate Operand

| Bit   | 31 | 30 | 29 | 28 | 27 | 26 | 25 | 2421 | 20—16 | 15—0 |
|-------|----|----|----|----|----|----|----|------|-------|------|
| Field | 0  | 0  | 0  | 1  | 1  | 0  | 1  | F    | D     | N    |

#### Format 6d. 24-Bit Arithmetic/Logic Group - Immediate Operand

| Bit   |   | 31 | 30 | 29 | 28 | 27 | 26 | 25 | 24—21 | 20—16 | 15—0 |
|-------|---|----|----|----|----|----|----|----|-------|-------|------|
| Field | 1 | 1  | 0  | 0  | 1  | 1  | 0  | 1  | F     | D     | N    |

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### CA Instruction Formats (Eight Format Groups) (continued)

#### Format 7a. Data Move Group - Direct Memory Address

| Bit   | 31 | 30 | 29 | 28 | 27 | 26 | 25 | 24 | 23 | 22 | 21 | 20—16 | 15—0 |
|-------|----|----|----|----|----|----|----|----|----|----|----|-------|------|
| Field | 0  | 0  | 0  | 1  | 1  | 1  | 0  | Т  | ۱  | N  | 0  | Н     | Ν    |

Format 7b. Data Move Group - Pointer Increment, Memory Address

| Bit   | 31 | 30 | 29 | 28 | 27 | 26 | 25 | 24 | 23 | 22 | 21 | 20—16 | 15—11 | 10 | 9—5 | 4—0 |
|-------|----|----|----|----|----|----|----|----|----|----|----|-------|-------|----|-----|-----|
| Field | 0  | 0  | 0  | 1  | 1  | 1  | 1  | Т  | V  | V  | 1  | н     | —     | r  | Р   | I   |

#### Format 7c. Data Move Group - I/O

| Bit   | 31 | 30 | 29 | 28 | 27 | 26 | 25 | 24 | 23 | 22 | 21 | 20—16 | 15—10 | 95    | 40 |
|-------|----|----|----|----|----|----|----|----|----|----|----|-------|-------|-------|----|
| Field | 0  | 0  | 0  | 1  | 1  | 1  | 1  | Т  | V  | V  | 0  | Н     |       | 00000 | R  |

#### Format 7d. Data Move Group --- Memory to I/O

| Bit   | 31 | 30 | 29 | 28 | 27 | 26 | 25 | 24 | 23 | 22 | 21 | 20—16 | 15—11 | 10 | 9—5 | 40 |
|-------|----|----|----|----|----|----|----|----|----|----|----|-------|-------|----|-----|----|
| Field | 0  | 0  | 0  | 1  | 1  | 1  | 0  | Т  | ٧  | /  | 1  | R     |       | r  | Р   | I  |

Format 8a. Unconditional Branch: 24-Bit Register-Indirect with 24-Bit Offset

| Bit   | 31 | 30 | 29 | 2821 | 20—16 | 15—0 |
|-------|----|----|----|------|-------|------|
| Field | 1  | 0  | 1  | NE   | Н     | N    |

#### Format 8b. 24-Bit Immediate Load

| Bit   | 31 | 30 | 29 | 28—21 | 20—16 | 15—0 |
|-------|----|----|----|-------|-------|------|
| Field | 1  | 1  | 0  | NE    | н     | N    |

#### Format 8c. Call Subroutine: 24-Bit Direct Immediate Address

| Bit   | 31 | 30 | 29 | 28—21 | 20—16 | 15—0 |
|-------|----|----|----|-------|-------|------|
| Field | 1  | 1  | 1  | NE    | М     | N    |

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### **CAU Encoding for CA Instruction Formats**

**C Field.** Specifies a CA, DA, or I/O condition. For Format 6a and 6b instructions, only CA conditions are allowed, and are specified by the three least significant bits of the C field.

| C     | Operation     |
|-------|---------------|
| 00xxx | CA Condition  |
| 00000 | No condition  |
| 00001 | n             |
| 00010 | z             |
| 00011 | v             |
| 00100 | с             |
| 00101 | n^v           |
| 00110 | z   (n ^ v)   |
| 00111 | clz           |
| 01xxx | DA Condition  |
| 01000 | U             |
| 01001 | N             |
| 01010 | Z             |
| 01011 | V             |
| 01100 | NIZ           |
| 01101 | Reserved      |
| 01110 | Reserved      |
| 01111 | Reserved      |
| 10xxx | I/O Condition |
| 10000 | ibf           |
| 10001 | obe           |
| 10010 | pdf           |
| 10011 | pif           |
| 10100 | sy            |
| 10101 | fb            |
| 10110 | ireq1         |
| 10111 | ireq2         |

**T Field.** Specifies the direction of a transfer to or from a register.

| Т | Operation                               |
|---|---|
| 0 | Data is moved to a register from memory |
| 1 | Data is moved to memory from a register |

**E Field.** Specifies whether the instruction is a two- or three-operand instruction.

| E | Operation                                   |
|---|---|
| 0 | Two-operand instruction                     |
| 1 | Three-operand instruction (register source) |

**K Field.** Specifies whether the instruction is to be executed based on the condition field.

| К | Operation                |
|---|--------------------------|
| 0 | Nonconditional execution |
| 1 | Conditional execution    |

**W Field.** Specifies the high or low byte or integer data.

| W  | Operation |
|----|-----------|
| 00 | High byte |
| 01 | Low byte  |
| 10 | Integer   |
| 11 | 32 bits   |

**G Field.** Specifies whether to branch if the condition specified in the C field is true or false.

| G | Operation               |  |
|---|-------------------------|--|
| 0 | Branch if condition = 0 |  |
| 1 | Branch if condition = 1 |  |

**F Field.** Specifies the arithmetic/logic group function encoding.

| F    | Operation                       |
|------|---------------------------------|
| 0000 | + addition                      |
| 0001 | *2 multiplication by 2          |
| 0010 | - subtraction {N, rS} - rD      |
| 0011 | # carry-reverse add             |
| 0100 | - subtraction rD - {N, rS}      |
| 0101 | - negation                      |
| 0110 | & ≈ and with complement         |
| 0111 | - compare (no store)            |
| 1000 | ^ exclusive or                  |
| 1001 | >>>1 rotate right through carry |
| 1010 | I bitwise OR                    |
| 1011 | <<<1 rotate left through carry  |
| 1100 | >>1 shift right by 1            |
| 1101 | /2 divide by 2                  |
| 1110 | & bitwise AND                   |
| 1111 | & bitwise AND (no store)        |

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# CAU Encoding for CA Instruction Formats (continued)

| S, | D, | Μ, | or | Н | Fields. | Used | for | register | encoding. |
|----|----|----|----|---|---------|------|-----|----------|-----------|
|----|----|----|----|---|---------|------|-----|----------|-----------|

| S, D, M, or H | Operation            |
|---------------|----------------------|
| 00000         | 0                    |
| 00001         | r1                   |
| 00010         | r2                   |
| 00011         | r3                   |
| 00100         | r4                   |
| 00101         | r5                   |
| 00110         | r6                   |
| 00111         | r7                   |
| 01000         | r8                   |
| 01001         | r9                   |
| 01010         | r10                  |
| 01011         | r11                  |
| 01100         | r12                  |
| 01101         | r13                  |
| 01110         | r14                  |
| 01111         | Program counter (pc) |
| 10000         | 0                    |
| 10001         | r15                  |
| 10010         | r16                  |
| 10011         | r17                  |
| 10100         | r18                  |
| 10101         | r19                  |
| 10110         | -4(f), -2(i), -1(b)  |
| 10111         | +4(f), +2(i), +1(b)  |
| 11000         | r20 (pin)            |
| 11001         | r21 (pout)           |
| 11010         | dauc                 |
| 11011         | ioc                  |
| 11100         | Reserved             |
| 11101         | r22 (ivtp)           |
| 11110         | pcsh (pc shadow)     |
| 11111         | Reserved             |

| •     | oporation         |
|-------|-------------------|
| 00000 | Selects Format 7C |
| 00001 | r1                |
| 00010 | r2                |
| 00011 | r3                |
| 00100 | r4                |
| 00101 | r5                |
| 00110 | r6                |
| 00111 | r7                |
| 01000 | r8                |
| 01001 | r9                |
| 01010 | r10               |
| 01011 | r11               |
| 01100 | r12               |
| 01101 | r13               |
| 01110 | r14               |
| 01111 | Reserved          |
| 10000 | Reserved          |
| 10001 | r15               |
| 10010 | r16               |
| 10011 | r17               |
| 10100 | r18               |
| 10101 | r19               |
| 10110 | Reserved          |
| 10111 | Reserved          |
| 11000 | r20 (pin)         |
| 11001 | r21 (pout)        |
| 11010 | Reserved          |
| 11011 | Reserved          |
| 11100 | Reserved          |
| 11101 | r22 (ivtp)        |
| 11110 | Reserved          |
| 11111 | Reserved          |

**P Field.** Specifies a register-indirect data move: \*rP, \*rP++, \*rP--, \*rP++rI.

Operation

Р

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CAU Encoding for CA Instruction Formats (continued)

|  | I | Field. | Specifies a | register-indirect | operation. |
|--|---|--------|-------------|-------------------|------------|
|--|---|--------|-------------|-------------------|------------|

| 1     | Operation    |
|-------|--------------|
| 00000 | Reserved     |
| 00001 | r1           |
| 00010 | r2           |
| 00011 | r3           |
| 00100 | r4           |
| 00101 | r5           |
| 00110 | r6           |
| 00111 | r7           |
| 01000 | r8           |
| 01001 | r9           |
| 01010 | r10          |
| 01011 | r11          |
| 01100 | r12          |
| 01101 | r13          |
| 01110 | r14          |
| 01111 | Reserved     |
| 10000 | 0            |
| 10001 | r15          |
| 10010 | r16          |
| 10011 | r17          |
| 10100 | r18          |
| 10101 | r19          |
| 10110 | -2(i), -1(b) |
| 10111 | +2(i), +1(b) |
| 11000 | r20 (pin)    |
| 11001 | r21 (pout)   |
| 11010 | Reserved     |
| 11011 | Reserved     |
| 11100 | Reserved     |
| 11101 | r22 (ivtp)   |
| 11110 | Reserved     |
| 11111 | Reserved     |

**r Field.** Specifies bit-reversed addressing mode (carry-reverse add with register).

| r | Operation       |
|---|-----------------|
| 0 | Nonbit-reversed |
| 1 | Bit-reversed    |

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**N Field.** Specifies a 16-bit integer included as immediate data or as an address.

**NE Field.** Specifies most significant 8 bits of 24-bit integer included as an immediate. NE concatenated with N forms the 24-bit integer.

**R Field (P = 00000).** Specifies a register-direct operation. This field is valid when the P field is zero.

| R     | <b>Operation (P = 00000)</b> |
|-------|------------------------------|
| 00000 | Reserved                     |
| 00001 | Reserved                     |
| 00010 | Reserved                     |
| 00011 | Reserved                     |
| 00100 | ibuf                         |
| 00101 | obuf                         |
| 00110 | pdr                          |
| 00111 | Reserved                     |
| 01000 | Reserved                     |
| 01001 | Reserved                     |
| 01010 | Reserved*                    |
| 01011 | Reserved                     |
| 01100 | Reserved                     |
| 01101 | Reserved                     |
| 01110 | piop                         |
| 01111 | Reserved                     |
| 10000 | Reserved                     |
| 10001 | Reserved                     |
| 10010 | Reserved                     |
| 10011 | Reserved                     |
| 10100 | pdr2                         |
| 10101 | Reserved                     |
| 10110 | pir                          |
| 10111 | Reserved                     |
| •     |                              |
| •     |                              |
| •     |                              |
| 11101 | Reserved                     |
| 11110 | pcw                          |
| 11111 | Reserved                     |

\* bkp access for development system use.

### **Register Operation**

This section describes the register settings which control or display various operating conditions in the DSP32C digital signal processor. Table 19 and Table 20 show the settings for the **ioc** and **dauc** registers. In Table 19, **internal** refers to signals generated by the DSP32C; **external** refers to signals generated for the DSP32C by an external device. The **ioc** register is cleared on reset.

### Input/Output Control (ioc) Register

#### Table 19. Input/Output Control (ioc) Register

| 0.4    | 00  | 10  | 10                                 | 17  | 10 | 15 10                               | 10  | 11 10               | 9       | 0        | 7      | 6 5     | 4       | 3        | 2 1    | 0       |
|--------|-----|-----|------------------------------------|---|----|-------------------------------------|-----|---------------------|---------|----------|--------|---------|---------|----------|--------|---------|
| Bit    | 20  | 19  |                                    | 17  | 16 | 15—13                               |     | 11 10               |         | 8        |        |         |         | <u> </u> |        | -       |
| Field  | DSZ | 024 | CKI                                | OUT   | IN | DMA                                 | SAN | OLEN                | AOL     | AOC      | ILE    | N AIL   | AIC     | SLE      | IN BC  | S ASY   |
| Bit(s) | Fi  | eld |                                    |   |    |                                     |     |                     | Descr   | iption   |        |         |         |          |        |         |
| 0      | A   | SY  |                                    |   |    |                                     |     | nternal.<br>BC) and |         |          |        |         | lly, SY | = {IC    | K, OC  | K} + 25 |
| 1      | E   | BC  |                                    | ICK is used to derive the internal load and SY signals. If 1, OCK is used to derive the nal load and SY signals.                |    |                                     |     |                     |         |          |        |         |         |          |        |         |
| 3, 2   | SL  | .EN |                                    | 0 0 32  |    |                                     |     |                     |         |          |        |         |         |          |        |         |
| 4      | A   | IC  |                                    | 0, ICK is external. If 1, ICK is generated internally with a frequency of CKI + 8 or<br>(I ÷ 24, based on <b>ioc[18]</b> (CKI). |    |                                     |     |                     |         |          |        |         |         |          |        |         |
| 5      | A   | ١L  |                                    |   |    |                                     |     | generate<br>;).     | ed inte | rnally v | vith a | freque  | ency of | ICK      | + 32 o | r       |
| 7, 6   | ß   | EN  | These<br>Bit 7<br>0<br>0<br>1<br>1 | 0 0 32 bits (prior to ILD)<br>0 1 8 bits (after ILD)<br>1 0 16 bits (after ILD)   |    |                                     |     |                     |         |          |        |         |         |          |        |         |
| 8      | A   | oc  |                                    |   |    | mal. If <b>1</b><br>on <b>ioc[1</b> |     | is interr<br>(I).   | ally ge | enerate  | d wit  | h a fre | quency  | of C     | KI + 8 | or      |
| 9      | A   | OL  | lf 0, O                            | 0, OLD is external. If 1, OLD is internally generated with a frequency of ICK + 32 or OCK + 32, based on <b>ioc[1]</b> (BC).    |    |                                     |     |                     |         |          |        |         |         |          |        |         |

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### Input/Output Control (ioc) Register (continued)

#### Table 19. Input/Output Control (ioc) Register (continued)

| [      |     |     |                       |  |               |                                       |                               |               | ·               |                     |  |             |              |                 |                  |                |             |        |                                       |
|--------|-----|-----|-----------------------|--|---------------|---------------------------------------|-------------------------------|---------------|-----------------|---------------------|--|-------------|--------------|-----------------|------------------|----------------|-------------|--------|---------------------------------------|
| Bit    | 20  | 19  | 18                    | 17   | 16            | 15—13                                 | 12                            | 11            | 10              | 9                   | 8  | 7           | 6            | 5               | 4                | з              | 2           | 1      | 0                                     |
| Field  | DSZ | O24 | скі                   | Ουτ  | IN            | DMA                                   | SAN                           | OL            | EN              | AOL                 | AOC  | ILI         | EN           | AIL             | AIC              | SL             | EN          | вс     | ASY                                   |
|        |     |     |                       |  |               |                                       |                               |               |                 |                     |  |             |              |                 |                  |                |             | ·      |                                       |
| Bit(s) | Fie | əld |                       |  |               |                                       |                               |               |                 | Descr               | iption   |             |              |                 |                  |                |             |        |                                       |
| 11, 10 | OLI | EN  | These                 | bits, i  | n co          | njunctior                             | ) with i                      | ioc[1         | <b>19]</b> (    | O24),               | 24), specify the length of the serial output data. |             |              |                 |                  |                |             |        |                                       |
|        |     |     | Bit 19                | 9 Bit  | 11            | Bit 10                                |                               |               |                 |                     |  |             |              |                 |                  |                |             |        |                                       |
|        |     |     | 0                     | (  | )             | 0                                     | 32 bits (no OSE is generated) |               |                 |                     |  |             |              |                 |                  |                |             |        |                                       |
|        |     |     | 0                     | (  | )             | 1                                     | 8 bits                        | S             |                 |                     |  |             |              |                 |                  |                |             |        |                                       |
|        |     |     | 0                     | 1  |               | 0                                     | 16 bi                         |               |                 |                     |  |             |              |                 |                  |                |             |        |                                       |
|        |     |     | 0                     | 1  |               | 1                                     | 32 bi                         |               |                 |                     |  |             |              |                 |                  |                |             |        |                                       |
|        |     |     | 1                     | (  | -             | 0                                     | 24 bi                         |               |                 |                     |  |             |              |                 |                  |                |             |        |                                       |
|        |     |     | 1                     | C  |               | 1                                     | Rese                          |               | _               |                     |  |             |              |                 |                  |                |             |        |                                       |
|        |     | _   | 1                     | 1  |               | X                                     | Rese                          |               |                 | -                   |  |             |              |                 |                  |                |             |        |                                       |
| 12     | SA  | N   | lf 0, cl              | ear sa   | nity          | bit. If 1,                            | set sa                        | nity          | bit.            |                     |  |             |              |                 |                  |                |             |        |                                       |
| 15—13  | DN  | /A  | These                 | bits c   | ontro         | ol serial c                           | lirect r                      | nem           | ory             | acces               | ses (DN  | /A).        | •            |                 |                  |                |             |        |                                       |
|        |     |     | Bit 15                | 5 Bit  | 14            | Bit 13                                |                               |               |                 |                     |  |             |              |                 |                  |                |             |        |                                       |
|        |     |     | 0                     | C  | )             | 0                                     | No D                          | MA            |                 |                     |  |             |              |                 |                  |                |             |        |                                       |
|        |     |     | 0                     | C  | )             | 1                                     | Input                         | DM            | A w             | hen IB              | F is hig   | h           |              |                 |                  |                |             |        |                                       |
|        |     |     | 0                     | 1  |               | 0                                     |                               |               |                 |                     | OBE is   |             |              |                 |                  |                |             |        |                                       |
|        |     |     | 0                     | 1  |               | 1                                     | Input                         | DM            | A wl            | hen IB              | F is hig   | ih a        | nd o         | outpu           | t DMA            | \ wh           | en          | OBE    | is high                               |
|        |     | ĺ   | 1                     | C  |               | 0                                     | Input                         | and           | out             | put DN              | viA whe  | en 1E       | 3F a         | ind C           | BE ar            | e hi           | gh          |        |                                       |
|        |     |     | 1                     | C  |               | 1                                     |                               |               |                 |                     | MA whe   |             |              |                 |                  |                |             |        |                                       |
|        |     |     | 1                     | 1  |               | 0                                     |                               |               |                 |                     | VIA whe  |             |              |                 |                  |                |             |        |                                       |
| •      |     |     | 1                     | 1  |               | 1                                     |                               |               |                 |                     | MA whe   |             |              |                 |                  |                |             |        | · · · · · · · · · · · · · · · · · · · |
| 16     | IN  |     | If 0, the<br>rial inp | e LSB<br>uts.  | is re         | eceived fi                            | irst du                       | ring          | seria           | al inpu             | its. If 1  | , the       | e M          | SB is           | receiv           | ved            | first       | duriı  | ng se-                                |
| 17     | OU  | Л   | lf 0, the             | e LSB<br>ial out   | is tr<br>puts | ansmitte<br>(cannot                   | d first<br>be us              | durir<br>ed w | ng se<br>/ith 2 | erial o<br>24-bit ( | utputs.<br>output I                                | lf 1<br>ena | , th<br>th). | e MS            | B is tr          | ans            | mitt        | ed fir | st dur-                               |
| 18     | CK  | (1  |                       | serial outputs (cannot be used with 24-bit output length).<br>the internal bit-clock frequency is CKI ÷ 8. If 1, the internal bit-clock frequency is ÷ 24. |               |                                       |                               |               |                 |                     |  |             |              |                 |                  |                |             |        |                                       |
| 19     | 02  | 4   | See O                 | ee OLEN, bits 11 and 10, for the use of this bit.  |               |                                       |                               |               |                 |                     |  |             |              |                 |                  |                |             |        |                                       |
| 20     | DS  | SZ  | lf 0, the<br>determ   | e data<br>nined t  | size<br>by th | e of input<br>e ILEN fi<br>(24-bit is | and o<br>eld an               | utpu<br>d th  | t DN<br>e da    | /A is 3<br>ta size  | 32 bits.   | lf 1<br>put | , th<br>DM   | e dat<br>A is c | a size<br>leterm | of in<br>ninea | npu<br>d by | t DM.  | A is<br>OLEN                          |

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### **DAU Control (dauc) Register**

### Table 20. DAU Control (dauc) Register

|        |       | Bit         4         3         2         1         0           Field         DAUC  |
|--------|-------|---|
| Bit(s) | Field | Description   |
| 4—0    | DAUC  | <ul> <li>This register controls the type conversions performed on input and output data. The permissible combinations are shown below:</li> <li>xx0x0 — μ-law input conversion</li> <li>xx0x1 — A-law input conversion</li> <li>x0x1x — A-law output conversion</li> <li>xx1xx — Linear byte input conversion</li> <li>x1xx — Linear byte output conversion</li> <li>x1xx — Linear byte output conversion</li> <li>x1xx — Truncate on float-to-integer conversions</li> <li>0xxxx — Round on float-to-integer conversions (default)</li> <li>Choosing the linear byte input and/or output mode will override the corresponding</li> <li>μ-law/A-law setting.</li> </ul> |

Note: x = don't care.

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### Parallel I/O Register Selection

The parallel I/O interface provides a processor address bus (PAB0—PAB3) to select access to the various PIO registers. Table 21 shows the register selections possible. Table 22 through Table 25 display the PIO registers. All PIO registers may be read or written by the external device, except **esr**, which is read-only, and the **pcw**, which is only accessible by the DSP32C. Bit 9 of the parallel I/O control register (**pcr[9]**) is used to configure an 8-bit or 16-bit parallel interface. **pcr[1]** provides a DSP32-compatible means of accessing the **pir** register. **pcr[9]** = 1 and **pcr[1]** = 0 should not be used together.

| PAB3— |                        | Register Selected      |                        |
|-------|------------------------|------------------------|------------------------|
| PAB0  | DSP32-Compatible Mode  | DSP32C 8-Bit Mode      | DSP32C 16-Bit Mode     |
|       | pcr[9] = 0, pcr[1] = 0 | pcr[9] = 0, pcr[1] = 1 | pcr[9] = 1, pcr[1] = 1 |
| 0000  | par(I) — iow byte      | par(I) — low byte      | par                    |
| 0001  | par(h) — high byte     | par(h) — high byte     | Reserved               |
| 0010  | pdr(l) — low byte      | pdr(l) — low byte      | pdr                    |
| 0011  | pdr(h) — high byte     | pdr(h) — high byte     | Reserved               |
| 0100  | emr(l) — low byte      | emr(l) — low byte      | emr                    |
| 0101  | emr(h) — high byte     | emr(h) — high byte     | Reserved               |
| 0110  | esr                    | esr                    | esr                    |
| 0111  | pcr(I) — low byte      | pcr(l) — low byte      | pcr                    |
| 1000  | pir(h) — high byte     | pir(l) — low byte      | pir                    |
| 1001  | pir(h) — high byte     | pir(h) — high byte     | Reserved               |
| 1010  | pir(h) — high byte     | pcr(h) — high byte     | Reserved*              |
| 1011  | pir(h) — high byte     | pare                   | pare                   |
| 1100  | pir(h) — high byte     | pdr2(I) low byte       | pdr2                   |
| 1101  | pir(h) — high byte     | pdr2(h) — high byte    | Reserved               |
| 1110  | pir(h) — high byte     | Reserved               | Reserved               |
| 1111  | pir(h) — high byte     | Reserved               | Reserved               |

| Table 21. | <b>PIO Register</b> | Selection |
|-----------|---------------------|-----------|
|-----------|---------------------|-----------|

\* pcr(h) accessible for development system use.

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### Parallel I/O Control Register (pcr)

The PIO control register (pcr) is a 16-bit register used by an external device to control transfer modes with the DSP32C device.

#### Table 22. Parallel I/O Control Register (pcr)

|        |        |               |  |                        |                        |                      |                             |                       |                     |                  |                            | ,                | ,             |
|--------|--------|---------------|--|------------------------|------------------------|----------------------|-----------------------------|-----------------------|---------------------|------------------|----------------------------|------------------|---------------|
| Bit    | 15-11  | 10            | 9  | 8                      | 7                      | 6                    | 5                           | 4                     | 3                   | 2                | 1                          | 0                |               |
| Field  | RES    | FLG           | PIO16  | DMA32                  | RES                    | PIFs                 | PDFs                        | AUTO                  | DMA                 | ENI              | REGMAP                     | RESET            | J             |
|        |        | - <u>1</u>    |  |                        |                        |                      |                             |                       |                     |                  |                            |                  |               |
| Bit(s) | Field  |               |  |                        |                        |                      | Des                         | criptior              | 1                   |                  |                            |                  |               |
| 0      | RESET  | lf 0,         | ), halt. If 1, run. A zero-to-one transition initiates a reset sequence.   |                        |                        |                      |                             |                       |                     |                  |                            |                  |               |
| 1      | REGMAP | Sele          | lects between the possible PAB-to-register mappings. (See Table 21.)   |                        |                        |                      |                             |                       |                     |                  |                            |                  |               |
| 2      | ENI    | pir.          | <ul> <li>disables setting (1) and clearing (0) of the PIF pin due to reading or writing of the</li> <li>If 1, enables setting (1) and clearing (0) of the PIF pin due to reading or writing of pir.</li> </ul> |                        |                        |                      |                             |                       |                     |                  |                            |                  |               |
| 3      | DMA    | lf 0,         | 0, PIO DMA is disabled. If 1, PIO DMA is enabled.  |                        |                        |                      |                             |                       |                     |                  |                            |                  |               |
| 4      | AUTO   | lf 0,         | 0, par is not autoincremented on DMA. If 1, par is autoincremented on DMA.   |                        |                        |                      |                             |                       |                     |                  |                            |                  |               |
| 5      | PDFs   | pdr<br>vice   | status (<br>. Cleare   | read only<br>ed (0) wh | ). Set<br>en <b>pd</b> | t (1) wl<br>r is rea | hen <b>pdi</b><br>ad by th  | r is writte<br>e DSP3 | en by tl<br>2C or a | he DS<br>an exte | P32C or an<br>ernal device | ı external<br>ə. | de-           |
| 6      | PIFs   | pir :<br>vice | status (r<br>. Cleare  | ead only)<br>ed (0) wh | . Set<br>en <b>pir</b> | (1) wh<br>is rea     | en <b>pir</b> i<br>d by the | s writter<br>e DSP32  | h by the<br>2C or a | e DSP<br>n exte  | 32C or an e<br>rnal device | external d       | le-           |
| 7      | RES    | Res           | erved.   |                        |                        |                      |                             |                       |                     |                  |                            |                  |               |
| 8      | DMA32  | If 0,         | DMA tra  | ansfers a              | re 16                  | bits ( <b>p</b>      | <b>dr</b> ). If 1           | , DMA t               | ransfe              | rs are           | 32 bits ( <b>pd</b>        | r and pdi        | r <b>2</b> ). |
| 9      | PIO16  | lf 0,         | the PIO  | interface              | e is 8 b               | oits. If             | 1, the i                    | nterface              | is 16 l             | oits.            |                            |                  |               |
| 10     | FLG    |               | 0, the PIO interface is 8 bits. If 1, the interface is 16 bits.<br>0, the PDF and PIF changes on the leading edge of reads. If 1, the PDF and PIF<br>hanges on the trailing edge of reads.                     |                        |                        |                      |                             |                       |                     |                  |                            | IF               |               |
| 11—15  | RES    | Res           | erved.   |                        |                        |                      |                             |                       |                     |                  |                            |                  |               |

Notes:

A reset sequence clears the contents of the pcr, except pcr[0] which is set. To achieve a setting other than the default, the pcr must be written again after the reset.

When configuring the DSP32C PIO for 16-bit transfers, since reset clears (0) **pcr[1]**, the PIO is initialized in the DSP32-compatible mode. **pcr(h)** is not accessible in this mode. To access **pcr(h)**, an external device must first write a logic 1 to **pcr[1]** (REGMAP). This places the PIO in the DSP32C 8-bit mode. **pcr(h)** may now be written (PAB3—PAB0 = 1010) to change the DMA32, PIO16, and FLG bits.

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### **Error Source Register (esr)**

The 8-bit error source register (esr) is a read-only register which is readable only by the external system. The register, which is cleared after a read operation, stores the error condition status.

#### Table 23. Error Source Register (esr)

|     |       | Bit           | 7  | 6        | 5         | 4        | 3        | 2     | 1   | 0   | ]             |
|-----|-------|---------------|--|----------|-----------|----------|----------|-------|-----|-----|---------------|
|     |       | Field         | LOSY   | LOS      | ADER      | OUE      | RES      | WPIR  | NAN | RES | ]             |
| Bit | Field |               | · · · ·  |          |           | Desc     | ription  |       |     |     |               |
| 0   | RES   | Reserved      |  |          |           |          |          |       |     |     |               |
| 1   | NAN   | If set (1), / | set (1), IEEE-to-DSP32 conversion detected a NaN.  |          |           |          |          |       |     |     |               |
| 2   | WPIR  | If set (1), t | If set (1), the <b>pir</b> was written.  |          |           |          |          |       |     |     |               |
| 3   | RES   | Reserved.     |  |          |           |          |          |       |     |     |               |
| 4   | OUE   | If set (1), I | DAU over   | flow or  | underflow | v occurr | ed.      |       |     |     |               |
| 5   | ADER  |               |  |          |           |          |          |       |     |     | or an integer |
| 6   | LOS   |               | ariable with an address that was not a multiple of four or two, respectively.<br>oss of sanity. If set (1), sanity bit in the <b>ioc</b> register is set (1), and SY changes state<br>rom high to low. |          |           |          |          |       |     |     |               |
| 7   | LOSY  | Loss of sy    | nc. If set   | (1), los | s of exte | rnal syn | chroniza | tion. |     |     |               |

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### Register Operation (continued)

### Error Mask Register (emr)

The 16-bit error mask register (**emr**) can be read or written by the external device and is divided into two halves. Bits 0, 2, and 3 and bits 8, 10, and 11 are reserved. When the **emr** is read, these bits are all read as logic one. **emr[1]** and **emr[4—7]**, when set (1), mask the corresponding error condition in the **esr** for signaling an external device. Similarly, **emr[9]** and **emr[12—15]**, when set (1), mask the corresponding error condition in the **esr** (i.e., bit 9 of the **emr** corresponds to bit 1 of the **esr**) for halting the DSP32C. When the DSP32C is reset, all **emr** bits are set (1).

#### Table 24. Error Mask Register (emr)

|      |              |                    |   | ·          |          |                |            |            |               |               |               |                       |                |             | _             |                   |               |
|------|--------------|--------------------|---|------------|----------|----------------|------------|------------|---------------|---------------|---------------|-----------------------|----------------|-------------|---------------|-------------------|---------------|
|      | Bit          | 15 14              |   | 12 11      |          | 9 8            | 3          | 7          | 6             | 5             | 4             |                       | 2 1            |             | )             |                   |               |
|      | Fiel         | d                  |   | Halt Mas   | k        |                |            |            | <u>P</u>      | F No          | otifica       | ation                 | Mas            | <u>k</u>    |               |                   |               |
|      |              |                    |   |            |          |                |            |            |               |               |               |                       |                |             |               |                   | <u>.</u> .    |
| Bits | Field        |                    |   |            |          |                |            |            | iptio         |               |               |                       |                |             |               |                   | <u> </u>      |
| 0—7  | PIF          | Each bit           | in the fi   | ield is se | t (1) to | mask           | ead        | ch d       | corre         | espo          | ndin          | g <b>es</b>           | <b>r</b> bit f | rom         | sigr          | naling            | l the         |
|      | Notification | external           | device  | (via the l | PIF pir  | i) wher        | n ar       | n er       | ror           | sour          | ce is         | dete                  | ected.         | lf a        | a bit         | in thi            | s field       |
|      | Mask         | is cleare          | d (0), th   | ne corres  | pondir   | ng <b>esr</b>  | bit i      | is u       | nma           | aske          | d to a        | allow                 | the o          | exte        | rnal          | devic             | e to be       |
|      |              | signaled           | if the e  |            |          |                |            |            |               |               |               |                       |                |             |               |                   |               |
|      |              | <u>emr</u>         | <u>e</u>  |            |          | Source         |            |            |               |               |               |                       |                |             |               |                   |               |
| ŀ    |              | 0                  |   |            |          |                |            |            |               |               |               |                       |                |             |               |                   |               |
|      |              | 1                  | · · ·   |            |          |                |            |            |               |               |               |                       |                |             |               |                   |               |
|      |              | 2                  |   |            |          |                |            |            |               |               |               |                       |                |             |               |                   |               |
|      |              |                    | 3 3 Reserved<br>4 4 OUE — DAU Overflow/Underflow Occurred |            |          |                |            |            |               |               |               |                       |                |             |               |                   |               |
|      |              | 4                  |   | -          |          |                |            |            |               |               | lerflo        | w O                   | ccurre         | ed          |               |                   |               |
|      |              | 5                  |   |            |          | — Ad           |            |            |               | rror          |               |                       |                |             |               |                   |               |
|      |              | 6                  |   |            |          | – Loss         |            |            |               |               |               |                       |                |             |               |                   |               |
|      |              | 7                  |   |            |          | — Los          |            |            |               |               |               |                       |                |             |               |                   |               |
| 8—15 | Halt Mask    | Each bit<br>DSP32C | in the f  | ield is se | t (1) to | mask<br>is det | ea<br>acte | ch (<br>ed | corre<br>If a | espo<br>hit i | ndin<br>n thi | g <b>es</b><br>s fiel | rbitf<br>disc  | rom<br>lear | halt<br>ed (( | ing th<br>)), the | e<br>e corre- |
|      |              | sponding           | n eer hi  | t is unma  | isked 1  |                | v th       | e D        | SP2           | 32C           | to be         | hali                  | ed if          | the         | erro          | was               | de-           |
|      |              | tected.            | ,   |            |          | e une.         | • • • •    |            |               |               |               |                       |                |             |               |                   |               |
|      |              | emr                | е   | sr         | Error \$ | Source         |            |            |               |               |               |                       |                |             |               |                   |               |
|      |              | 8                  |   |            | Reser    |                |            |            |               |               |               |                       |                |             |               |                   |               |
|      |              | 9                  |   | 1          | NaN -    | – Not a        | a N        | uml        | ber           | (IEE          | E-to-         | DSF                   | 22C)           | 1           |               |                   |               |
|      |              | 10                 |   | 2          | Reser    | ved            |            |            |               |               |               |                       |                |             |               |                   |               |
|      |              | 11                 |   | 3          | Reser    | ved            |            |            |               |               |               |                       |                |             |               |                   |               |
|      |              | 12                 |   | 4          | OUE -    | - DAL          | J O        | verl       | low           | /Unc          | lerflo        | w O                   | ccurre         | ed          |               |                   |               |
|      |              | 13                 |   | 5          | ADER     | — Ad           | dre        | ssir       | ng E          | rror          |               |                       |                |             |               |                   |               |
|      |              | 14                 |   | 6          |          | - Loss         |            |            | -             |               |               |                       |                |             |               |                   |               |
|      |              | 15                 |   | 7          | LOSY     | — Los          | ss c       | of E       | xter          | nal S         | Sync          |                       |                |             |               |                   |               |

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### **Register Operation** (continued)

### Processor Control Word (pcw) Register

### Table 25. Processor Control Word (pcw) Register

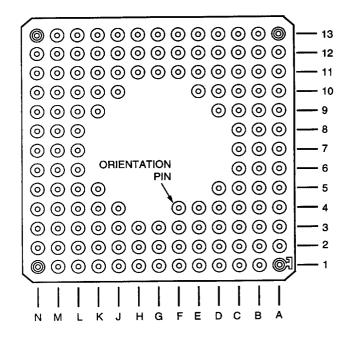
| Bit    | 15 14 | <b>1</b> 13 12 11 10 9 8 7 6 5 4 3 2 1 0  |  |  |  |  |  |  |  |  |
|--------|-------|---|--|--|--|--|--|--|--|--|
| Field  |       | INTER PEND MGN PIOPH PIOPL MEMA MEMB WA WB  |  |  |  |  |  |  |  |  |
|        |       |   |  |  |  |  |  |  |  |  |
| Bit(s) | Field | Description   |  |  |  |  |  |  |  |  |
| 0      | WB    | If 0, disable wait-state generator for external memory partition B. If 1, enable wait-<br>state generator for external memory partition B.  |  |  |  |  |  |  |  |  |
| 1      | WA    | If 0, disable wait-state generator for external memory partition A. If 1, enable wait-<br>state generator for external memory partition A.  |  |  |  |  |  |  |  |  |
| 3, 2   | MEMB  | nese bits select the number of wait-states that will be generated for the external<br>emory in partition B.<br>00 — 1 wait-state*<br>01 — 2 wait-states<br>10 — 3 wait-states<br>11 — 2 or more wait-states (controlled by SRDYN signal)  |  |  |  |  |  |  |  |  |
| 5, 4   | MEMA  | nese bits select the number of wait-states that will be generated for the external<br>emory in partition A.<br>00 — 1 wait-state*<br>01 — 2 wait-states<br>10 — 3 wait-states<br>11 — 2 or more wait-states (controlled by SRDYN signal)  |  |  |  |  |  |  |  |  |
| 6      | PIOPL | If 0, PIOP3—PIOP0 are inputs. If 1, PIOP3—PIOP0 are outputs when <b>pcr[9]</b> (PIO16) = 0.   |  |  |  |  |  |  |  |  |
| 7      | PIOPH | If 0, PIOP7—PIOP4 are inputs. If 1, PIOP7—PIOP4 are outputs when pcr[9](PIO16) = 0.   |  |  |  |  |  |  |  |  |
| 8      | MGN   | If 0, the MGN pin acts as a memory output enable signal. If 1, the MGN pin is used<br>by the bus arbitration protocol to indicate that an external memory access is pending.  |  |  |  |  |  |  |  |  |
| 9      | PEND  | If $pcw[8](MGN) = 0$ , this bit is not used. If $pcw[8] = 1$ , the logical value of this bit is ORed with an internal signal that indicates an external access is pending. It is then inverted to produce the signal at the MGN pin (i.e., if $pcw[8](MGN) = 1$ and $pcw[9](PEND) = 1$ , then the pin MGN = 0). |  |  |  |  |  |  |  |  |
| 15—10  | INTER |   |  |  |  |  |  |  |  |  |

\* 1 wait-state = one period of CKI = 12.5 ns at maximum clock frequency.

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### **Pin Information**



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Figure 4. 133-Pin Square CPGA (DSP32C-R3) Diagram (Bottom View)

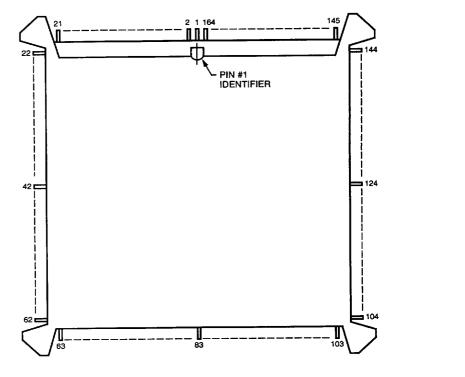


Figure 5. 164-Pin BQFP Package (DSP32C-F3) Diagram (Top View)

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### Pin Information (continued)

### **Pins by Functional Group Order**

#### Table 26. DSP32C Pin Descriptions

Please refer to the AT&T DSP32C Information Manual for a complete description of each pin.

| Pin<br>(BQFP) | Pin<br>(CPGA) | Symbol      | Type*  | Name/Description                      |
|---------------|---------------|-------------|--------|---------------------------------------|
| 108           | D13           | AB00        | O(3)   | External Memory Address Bus — Bit 0.  |
| 110           | D12           | AB01        |        | External Memory Address Bus — Bit 1.  |
| 111           | C13           | AB02        |        | External Memory Address Bus — Bit 2.  |
| 112           | C12           | AB03        |        | External Memory Address Bus — Bit 3.  |
| 114           | B13           | AB04        |        | External Memory Address Bus — Bit 4.  |
| 115           | B12           | AB05        |        | External Memory Address Bus — Bit 5.  |
| 118           | A13           | AB06        |        | External Memory Address Bus — Bit 6.  |
| 120           | A12           | AB07        |        | External Memory Address Bus — Bit 7.  |
| 123           | B11           | AB08        |        | External Memory Address Bus — Bit 8.  |
| 122           | A11           | AB09        |        | External Memory Address Bus — Bit 9.  |
| 124           | B10           | AB10        |        | External Memory Address Bus — Bit 10. |
| 127           | A10           | AB11        |        | External Memory Address Bus — Bit 11. |
| 128           | A9            | AB12        |        | External Memory Address Bus — Bit 12. |
| 130           | A8            | AB13        |        | External Memory Address Bus — Bit 13. |
| 131           | B6            | AB14        |        | External Memory Address Bus — Bit 14. |
| 132           | C7            | AB15        |        | External Memory Address Bus — Bit 15. |
| 126           | B8            | AB16        |        | External Memory Address Bus — Bit 16. |
| 119           | C8            | AB17        |        | External Memory Address Bus — Bit 17. |
| 116           | C9            | AB18        |        | External Memory Address Bus — Bit 18. |
| 107           | C10           | AB19        |        | External Memory Address Bus — Bit 19. |
| 100           | D10           | AB20        |        | External Memory Address Bus — Bit 20. |
| 106           | E10           | AB21        |        | External Memory Address Bus — Bit 21. |
| 152           | A2            | DB00        | I/O(3) | External Memory Data Bus — Bit 0.     |
| 153           | A1            | DB01        |        | External Memory Data Bus — Bit 1.     |
| 154           | B3            | DB02        |        | External Memory Data Bus — Bit 2.     |
| 156           | B2            | DB03        |        | External Memory Data Bus — Bit 3.     |
| 157           | B1            | DB04        |        | External Memory Data Bus — Bit 4.     |
| 158           | C2            | DB05        |        | External Memory Data Bus — Bit 5.     |
| 160           | C1            | DB06        |        | External Memory Data Bus — Bit 6.     |
| 161           | D3            | DB07        |        | External Memory Data Bus — Bit 7.     |
| 162           | D2            | DB08        |        | External Memory Data Bus — Bit 8.     |
| 164           | D1            | DB09        |        | External Memory Data Bus — Bit 9.     |
| 2             | E2            | <b>DB10</b> |        | External Memory Data Bus — Bit 10.    |
| 5             | E1            | DB11        |        | External Memory Data Bus — Bit 11.    |

\* I = input; O = output; (3) = 3-state, P = power.

<sup>†</sup> PAB3 is labeled PACK in the DSP32.

<sup>‡</sup> PIF is labeled PINT in the DSP32.

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### Pin Information (continued)

### Pins by Functional Group Order (continued)

#### Table 26. DSP32C Pin Descriptions (continued)

Please refer to the AT&T DSP32C Information Manual for a complete description of each pin.

| Pin<br>(BQFP) | Pin<br>(CPGA) | Symbol | Туре*  | Name/Description   |
|---------------|---------------|--------|--------|--|
| 3             | F3            | DB12   | I/O(3) | External Memory Data Bus — Bit 12.   |
| 6             | F2            | DB13   |        | External Memory Data Bus — Bit 13.   |
| 7             | F1            | DB14   |        | External Memory Data Bus — Bit 14.   |
| 9             | G2            | DB15   |        | External Memory Data Bus — Bit 15.   |
| 10            | G1            | DB16   |        | External Memory Data Bus — Bit 16.   |
| 11            | H3            | DB17   |        | External Memory Data Bus — Bit 17.   |
| 13            | H2            | DB18   |        | External Memory Data Bus — Bit 18.   |
| 14            | H1            | DB19   |        | External Memory Data Bus — Bit 19.   |
| 15            | J2            | DB20   |        | External Memory Data Bus — Bit 20.   |
| 27            | J1            | DB21   |        | External Memory Data Bus — Bit 21.   |
| 25            | К3            | DB22   |        | External Memory Data Bus — Bit 22.   |
| 29            | K2            | DB23   |        | External Memory Data Bus — Bit 23.   |
| 31            | K1            | DB24   |        | External Memory Data Bus — Bit 24.   |
| 32            | L2            | DB25   |        | External Memory Data Bus — Bit 25.   |
| 33            | L1            | DB26   |        | External Memory Data Bus — Bit 26.   |
| 37            | MЗ            | DB27   |        | External Memory Data Bus — Bit 27.   |
| 36            | M2            | DB28   |        | External Memory Data Bus — Bit 28.   |
| 35            | M1            | DB29   |        | External Memory Data Bus — Bit 29.   |
| 39            | N2            | DB30   |        | External Memory Data Bus — Bit 30.   |
| 40            | N1            | DB31   |        | External Memory Data Bus — Bit 31.   |
| 104           |               | EAPN   | O(3)   | <b>External Access Pending (Active-Low).</b> Indicates that the DSP32C has an external access pending but does not have ownership of its bus.                  |
| 101           | E12           | MMD0   | 1      | Memory Mode — Bit 0.   |
| 99            | E13           | MMD1   |        | Memory Mode — Bit 1.   |
| 148           | E4            | MMD2   |        | Memory Mode — Bit 2.<br>MMD0 and MMD1 select the address location of memory resources<br>(see Memory Configuration).   |
| 134           | A7            | MSN0   | O(3)   | Memory Select — Bit 0 (Active-Low).  |
| 135           | A6            | MSN1   |        | Memory Select — Bit 1 (Active-Low).  |
| 138           | A5            | MSN2   |        | Memory Select — Bit 2 (Active-Low).  |
| 140           | A4            | MSN3   |        | Memory Select — Bit 3 (Active-Low).<br>MSN0—MSN3 (Active-low) select individual bytes 0, 1, 2, or 3 of<br>memory addressed by the external memory address bus. |

I = input; O = output; (3) = 3-state, P = power.

<sup>†</sup> PAB3 is labeled PACK in the DSP32.

<sup>‡</sup> PIF is labeled PINT in the DSP32.

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## Pins by Functional Group Order (continued)

### Table 26. DSP32C Pin Descriptions (continued)

Please refer to the AT&T DSP32C Information Manual for a complete description of each pin.

| Pin<br>(BQFP) | Pin<br>(CPGA) | Symbol       | Туре*      | Name/Description   |
|---------------|---------------|--------------|------------|--|
| 142           | A3            | MGN/<br>EAPN | O(3)       | <b>Memory Output Enable/External Access Pending (Active-Low).</b><br>When <b>pcw[8]</b> = 0, MGN indicates that memory output should be<br>placed on the external memory data bus. When <b>pcw[8]</b> = 1, EAPN<br>indicates that the DSP32C has an external access pending but does<br>not have ownership of its bus. |
| 139           | B4            | MWN          | O(3)       | Memory Write (Active-Low). Controls data writes to memory.   |
| 136           | C6            | ASN          | O(3)       | Address Strobe (Active-Low). Indicates a valid address on the address bus.   |
| 143           | C5            | DSN          | O(3)       | <b>Data Strobe (Active-Low).</b> During a read transaction, DSN indi-<br>cates that data may be placed on the data bus. During a write trans-<br>action, DSN indicates that valid data is present on the data bus.   |
| 144           | C4            | CYCLEIN      | O(3)       | <b>Cycle Initiate (Active-Low).</b> Indicates the beginning of a valid external memory transaction.  |
| 150           | D4            | RWN          | O(3)       | <b>Read/Write.</b> If HIGH, memory transaction is a read operation, and, if LOW, memory transaction is a write operation.  |
| 149           | F4            | SRDYN        | . <b>I</b> | Synchronous Ready (Active-Low). Indicates to the DSP32C that the memory transaction may be completed.  |
| 28            | L6            | BREQN        | I          | <b>Bus Request (Active-Low).</b> When asserted, the DSP32C places data, address, and control signals in the high-impedance state.  |
| 19            | K5            | BRACKN       | O(3)       | <b>Bus Request Acknowledge (Active-Low).</b> Indicates that the DSP32C has relinquished its address, data, and control lines, and that the external processor may access the external memory of the DSP32C.  |
| 24            | L5            | INTREQ1      | 1          | Interrupt Request 1 (Active-Low). Higher-priority external interrupt. Maskable in the pcw register.  |
| 23            | L4            | INTREQ2      | I          | Interrupt Request 2 (Active-Low). Lower-priority external interrupt. Maskable in the pcw register.   |
| 18            | K4            | IACK1        | O(3)       | Interrupt Acknowledge 1. Indicates the servicing of interrupt request 1.   |
| 17            | J4            | IACK2        | O(3)       | Interrupt Acknowledge 2. Indicates the servicing of interrupt request 2.   |
| 82            | K13           | PDB00        | I/O(3)     | Parallel Data Bus — Bit 0.   |
| 80            | K12           | PDB01        |            | Parallel Data Bus — Bit 1.   |
| 79            | K11           | PDB02        |            | Parallel Data Bus — Bit 2.   |
| 78            | L13           | PDB03        |            | Parallel Data Bus — Bit 3.   |
| 76            | L12           | PDB04        |            | Parallel Data Bus — Bit 4.   |

<sup>\*</sup> I = input; O = output; (3) = 3-state, P = power.
 <sup>†</sup> PAB3 is labeled PACK in the DSP32.

<sup>‡</sup> PIF is labeled PINT in the DSP32.

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### Pins by Functional Group Order (continued)

#### Table 26. DSP32C Pin Descriptions (continued)

Please refer to the AT&T DSP32C Information Manual for a complete description of each pin.

| Pin<br>(BQFP) | Pin<br>(CPGA) | Symbol                      | Type*  | Name/Description  |
|---------------|---------------|-----------------------------|--------|---|
| 75            | M13           | PDB05                       | I/O(3) | Parallel Data Bus — Bit 5.  |
| 74            | M12           | PDB06                       |        | Parallel Data Bus — Bit 6.  |
| 72            | M11           | PDB07                       |        | Parallel Data Bus — Bit 7.  |
| 66            | J10           | PDB08/<br>PIOP0             | I/O(3) | Parallel Data Bus — Bit 8/PIO Port — Bit 0.   |
| 67            | K10           | PDB09/<br>PIOP1             |        | Parallel Data Bus — Bit 9/PIO Port — Bit 1.   |
| 68            | L10           | PDB10/<br>PIOP2             |        | Parallel Data Bus — Bit 10/PIO Port — Bit 2.  |
| 61            | N11           | PDB11/<br>PIOP3             |        | Parallel Data Bus — Bit 11/PIO Port — Bit 3.  |
| 60            | M10           | PDB12/<br>PIOP4             |        | Parallel Data Bus — Bit 12/PIO Port — Bit 4.  |
| 59            | L9            | PDB13/<br>PIOP5             |        | Parallel Data Bus — Bit 13/PIO Port — Bit 5.  |
| 53            | L8            | PDB14/<br>PIOP6             |        | Parallel Data Bus — Bit 14/PIO Port — Bit 6.  |
| 52            | L7            | PDB15/<br>PIOP7             |        | Parallel Data Bus — Bit 15/PIO Port — Bit 7.  |
| 89            | H13           | PAB0                        | I      | Processor Address Bus — Bit 0.  |
| 91            | G12           | PAB1                        |        | Processor Address Bus — Bit 1.  |
| 92            | G13           | PAB2                        |        | Processor Address Bus — Bit 2.  |
| 84            | J12           | PAB3<br>(PACK) <sup>†</sup> |        | Processor Address Bus — Bit 3.<br>PAB0—PAB3 are decoded to select the appropriate PIO register.   |
| 85            | J13           | PEN                         | I      | Processor Interface Enable (Active-Low). When active, PEN allows a read or a write of the PIO data bus (PDB).   |
| 87            | H12           | PGN                         | 1      | Processor Read Enable (Active-Low). Allows an external micro-<br>processor to read data from the selected PIO register.   |
| 88            | H11           | PWN                         | 1      | <b>Processor Write Enable (Active-Low).</b> When active, enables on-<br>chip registers to be written by an external microprocessor.   |
| 70            | N12           | PIF<br>(PINT) <sup>‡</sup>  | O(3)   | Parallel Interrupt Full. Interrupt to $\mu$ P. PIF is set when a non-<br>masked error occurs, or when the DSP32C or an external micropro-<br>cessor writes to <b>pir</b> , and <b>pcr[2]</b> is set; PIF is cleared when <b>esr</b> or <b>pir</b><br>is read by the $\mu$ P, or <b>pir</b> is read by the DSP32C. |
| 71            | N13           | PDF                         | O(3)   | <b>Parallel Data Full.</b> Set when <b>pdr</b> is written by the DSP32C or an external microprocessor; cleared when <b>pdr</b> is read by the DSP32C or an external microprocessor.   |

\* I = input; O = output; (3) = 3-state, P = power.

<sup>†</sup> PAB3 is labeled PACK in the DSP32.

<sup>‡</sup> PIF is labeled PINT in the DSP32.

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## Pins by Functional Group Order (continued)

#### Table 26. DSP32C Pin Descriptions (continued)

Please refer to the AT&T DSP32C Information Manual for a complete description of each pin.

| Pin<br>(BQFP) | Pin<br>(CPGA) | Symbol | Type*  | Name/Description  |
|---------------|---------------|--------|--------|---|
| 57            | N10           | DI     |        | Data Input. Serial input PCM data.  |
| 47            | N6            | IBF    | O(3)   | Input Buffer Full. Indicates state of input buffer (ibuf). IBF is cleared when ibuf is loaded onto the data bus by the DSP32C.  |
| 56            | N9            | ICK    | I/O(3) | <b>Input Clock.</b> Clock for serial PCM input data. In internal mode, ICK is an output; in external mode, ICK is an input, depending on the <b>ioc</b> register.   |
| 55            | N8            | ILD    | I/O(3) | <b>Input Load.</b> Clock for loading input buffer from serial-to-parallel converter. In internal mode, ILD is an output; in external mode, ILD is an input, depending on the <b>ioc</b> register.                           |
| 43            | M4            | DO     | O(3)   | Data Output. Serial output PCM data. 3-stated when OEN is set.  |
| 45            | N5            | OBE    | O(3)   | <b>Output Buffer Empty.</b> Indicates the state of serial PCM output buffer ( <b>obuf</b> ). OBE is cleared when <b>obuf</b> is written by the DSP32C.  |
| 51            | M8            | OCK    | I/O(3) | <b>Output Clock.</b> Clock for serial PCM output data. In internal mode, OCK is an output; in external mode, OCK is an input, depending on the <b>ioc</b> register.   |
| 49            | N7            | OLD    | I/O(3) | <b>Output Load.</b> Clock for loading parallel-to-serial converter from <b>obuf</b> . In internal mode, OLD is an output; in external mode, OLD is an input, depending on the <b>ioc</b> register.                          |
| 44            | N4            | OSE    | O(3)   | <b>Output Shift Register Empty.</b> Indicates end of serial output transmission. OSE is the complement of OLD delayed by the number of bits in the transmission, as set by the <b>ioc</b> register.                         |
| 41            | N3            | OEN    | I      | Output Enable (Active-Low). Enables DO for output. When high, DO is 3-stated.   |
| 48            | M6            | SY     | I/O(3) | <b>Synchronization.</b> Internal mode (Output)—DSP32C provides frame sync. External mode (Input)—frame sync is provided to the DSP32C. (May also be used as a general-purpose status pin when configured in external mode.) |

I = input; O = output; (3) = 3-state, P = power.
 PAB3 is labeled PACK in the DSP32.

<sup>‡</sup> PIF is labeled PINT in the DSP32.

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### Pins by Functional Group Order (continued)

### Table 26. DSP32C Pin Descriptions (continued)

Please refer to the AT&T DSP32C Information Manual for a complete description of each pin.

| Pin<br>(BQFP)  | Pin<br>(CPGA)   | Symbol | Type* | Name/Description  |
|--|---|--------|-------|---|
| 96   | D11   | CKI    | I     | Clock In. System clock.   |
| 93   | F11   | СКО    | O(3)  | <b>Clock Out.</b> Buffered clock at the same frequency as CKI.<br>Synchronizes external devices to the DSP32C.  |
| 95   | F12   | RESTN  | Ι     | <b>Reset (Active-Low).</b> Controls the DSP32C run/halt state. A low level causes entry into the halt state. The low-to-high transition causes the reset sequence. Reset sequence stores <b>pc</b> in <b>r14</b> ; clears <b>pc</b> , <b>ioc</b> , <b>esr</b> ; and sets <b>emr</b> to mask all errors. The <b>pcr</b> register bits, except <b>pcr[0]</b> , are cleared; <b>pcr[0]</b> is set. CAU and DAU condition flags and the <b>dauc</b> register are not affected by reset. The <b>pcw</b> register is set to generate two or more wait-states (depending on SRDYN signal) for external memory. |
| 97   | F13   | ZN     | I(R)  | <b>3-State (Active-Low).</b> When active, all DSP32C output pins are 3-stated. When not connected, ZN is inactive. Used for power-on reset.   |
| 8, 16, 26,<br>34, 42, 50,<br>58, 69, 77,<br>86, 94,<br>105, 113,<br>121, 129,<br>137, 147,<br>155, 163 | B7, E3,<br>E11, J3,<br>J11, M7  | Vdd    | Ρ     | +5 V.   |
| 4, 12, 22,<br>30, 38, 46,<br>54, 65, 73,<br>81, 90, 98,<br>109, 117,<br>125, 133,<br>141, 151,<br>159  | B5, B9,<br>C3, C11,<br>D5, D9,<br>G3, G11,<br>K9, L3,<br>L11, M5,<br>M9 | Vss    | Ρ     | Ground.   |

\* != input; O = output; (3) = 3-state, P = power.
† PAB3 is labeled PACK in the DSP32.
‡ PIF is labeled PINT in the DSP32.

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### **Pins by Numerical Order**

### Table 27. DSP32C Pin Descriptions—CPGA Package

Please refer to the AT&T DSP32C Information Manual for a complete description of each pin.

| Pin | Symbol       | Type*  | Name  |
|-----|--------------|--------|---|
| A1  | DB01         | I/O(3) | External Memory Data Bus — Bit 1.             |
| A2  | DB00         | I/O(3) | External Memory Data Bus — Bit 0.             |
| A3  | MGN/<br>EAPN | O(3)   | Memory Output Enable/External Access Pending. |
| A4  | MSN3         | O(3)   | Memory Select — Bit 3.                        |
| A5  | MSN2         | O(3)   | Memory Select — Bit 2.                        |
| A6  | MSN1         | O(3)   | Memory Select — Bit 1.                        |
| A7  | MSN0         | O(3)   | Memory Select — Bit 0.                        |
| A8  | AB13         | O(3)   | External Memory Address Bus — Bit 13.         |
| A9  | AB12         | O(3)   | External Memory Address Bus — Bit 12.         |
| A10 | AB11         | O(3)   | External Memory Address Bus Bit 11.           |
| A11 | AB09         | O(3)   | External Memory Address Bus — Bit 9.          |
| A12 | AB07         | O(3)   | External Memory Address Bus — Bit 7.          |
| A13 | AB06         | O(3)   | External Memory Address Bus — Bit 6.          |
| B1  | DB04         | I/O(3) | External Memory Data Bus — Bit 4.             |
| B2  | DB03         | I/O(3) | External Memory Data Bus — Bit 3.             |
| B3  | DB02         | I/O(3) | External Memory Data Bus — Bit 2.             |
| B4  | MWN          | O(3)   | Memory Write.                                 |
| B5  | Vss          | P      | Ground.                                       |
| B6  | AB14         | O(3)   | External Memory Address Bus — Bit 14.         |
| B7  | Vdd          | Р      | +5 V.   |
| B8  | AB16         | O(3)   | External Memory Address Bus — Bit 16.         |
| B9  | Vss          | Р      | Ground.                                       |
| B10 | AB10         | O(3)   | External Memory Address Bus — Bit 10.         |
| B11 | AB08         | O(3)   | External Memory Address Bus — Bit 8.          |
| B12 | AB05         | O(3)   | External Memory Address Bus — Bit 5.          |
| B13 | AB04         | O(3)   | External Memory Address Bus — Bit 4.          |
| C1  | DB06         | I/O(3) | External Memory Data Bus — Bit 6.             |
| C2  | DB05         | I/O(3) | External Memory Data Bus — Bit 5.             |
| C3  | Vss          | Р      | Ground.                                       |
| C4  | CYCLEIN      | O(3)   | Cycle Initiate.                               |
| C5  | DSN          | O(3)   | Data Strobe.                                  |
| C6  | ASN          | O(3)   | Address Strobe.                               |

\* I = input; O = output; P = power; (3) = 3-state; (R) = on-chip pull-up.

<sup>†</sup> PAB3 is labeled PACK in the DSP32.

<sup>‡</sup> PIF is labeled PINT in the DSP32.

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### Pins by Numerical Order (continued)

### Table 27. DSP32C Pin Descriptions—CPGA Package (continued)

Please refer to the AT&T DSP32C Information Manual for a complete description of each pin.

| Pin        | Symbol | Type*           | Name                                  |
|------------|--------|-----------------|---------------------------------------|
| C7         | AB15   | O(3)            | External Memory Address Bus — Bit 15. |
| C8         | AB17   | O(3)            | External Memory Address Bus — Bit 17. |
| C9         | AB18   | O(3)            | External Memory Address Bus — Bit 18. |
| C10        | AB19   | O(3)            | External Memory Address Bus — Bit 19. |
| C11        | Vss    | Р               | Ground.                               |
| C12        | AB03   | O(3)            | External Memory Address Bus — Bit 3.  |
| C13        | AB02   | O(3)            | External Memory Address Bus — Bit 2.  |
| D1         | DB09   | I/O(3)          | External Memory Data Bus — Bit 9.     |
| D2         | DB08   | I/O(3)          | External Memory Data Bus — Bit 8.     |
| D3         | DB07   | I/O <u>(</u> 3) | External Memory Data Bus — Bit 7.     |
| D4         | RWN    | O(3)            | Read/Write.                           |
| D5         | Vss    | P               | Ground.                               |
| D9         | Vss    | P               | Ground.                               |
| D10        | AB20   | O(3)            | External Memory Address Bus — Bit 20. |
| D11        | CKI    | <u> </u>        | Clock in.                             |
| D12        | AB01   | O(3)            | External Memory Address Bus — Bit 1.  |
| D13        | AB00   | O(3)            | External Memory Address Bus — Bit 0.  |
| E1         | DB11   | I/O(3)          | External Memory Data Bus — Bit 11.    |
| E2         | DB10   | I/O(3)          | External Memory Data Bus — Bit 10.    |
| E3         | Vdd    | Р               | +5 V.                                 |
| E4         | MMD2   | <u> </u>        | Memory Mode — Bit 2.                  |
| E10        | AB21   | O(3)            | External Memory Address Bus — Bit 21. |
| E11        | Vdd    | Р               | +5 V.                                 |
| E12        | MMD0   | <u> </u>        | Memory Mode — Bit 0.                  |
| E13        | MMD1   | 1               | Memory Mode — Bit 1.                  |
| F1         | DB14   | I/O(3)          | External Memory Data Bus — Bit 14.    |
| F2         | DB13   | I/O(3)          | External Memory Data Bus — Bit 13.    |
| F3         | DB12   | I/O <u>(</u> 3) | External Memory Data Bus — Bit 12.    |
| <b>F</b> 4 | SRDYN  | <u> </u>        | Synchronous Ready.                    |
| F11        | СКО    | O(3)            | Clock Out.                            |
| F12        | RESTN  | <u> </u>        | Reset.                                |
| F13        | ZN     | 1(R)            | 3-state.                              |
| G1         | DB16   | I/O(3)          | External Memory Data Bus — Bit 16.    |
| G2         | DB15   | I/O(3)          | External Memory Data Bus — Bit 15.    |

I = input; O = output; P = power; (3) = 3-state; (R) = on-chip pull-up.
 PAB3 is labeled PACK in the DSP32.

<sup>‡</sup> PIF is labeled PINT in the DSP32.

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### Pins by Numerical Order (continued)

#### Table 27. DSP32C Pin Descriptions—CPGA Package (continued)

Please refer to the AT&T DSP32C Information Manual for a complete description of each pin.

| Pin | Symbol                      | Type*  | Name  |
|-----|-----------------------------|--------|---|
| G3  | Vss                         | P      | Ground.                                     |
| G11 | Vss                         | Р      | Ground.                                     |
| G12 | PAB1                        | l      | Processor Address Bus Bit 1.                |
| G13 | PAB2                        | l      | Processor Address Bus — Bit 2.              |
| H1  | DB19                        | I/O(3) | External Memory Data Bus Bit 19.            |
| H2  | DB18                        | I/O(3) | External Memory Data Bus — Bit 18.          |
| НЗ  | DB17                        | I/O(3) | External Memory Data Bus — Bit 17.          |
| H11 | PWN                         | 1      | Processor Write Enable.                     |
| H12 | PGN                         | 1      | Processor Read Enable.                      |
| H13 | PAB0                        | 1      | Processor Address Bus Bit 0.                |
| J1  | DB21                        | I/O(3) | External Memory Data Bus — Bit 21.          |
| J2  | DB20                        | I/O(3) | External Memory Data Bus — Bit 20.          |
| J3  | Vdd                         | Р      | +5 V.                                       |
| J4  | IACK2                       | O(3)   | Interrupt Acknowledge 2.                    |
| J10 | PDB08/<br>PIOP0             | I/O(3) | Parallel Data Bus — Bit 8/PIO Port — Bit 0. |
| J11 | Vdd                         | Р      | +5 V.                                       |
| J12 | PAB3<br>(PACK) <sup>†</sup> | I      | Processor Address Bus — Bit 3.              |
| J13 | PEN                         | I      | Processor Interface Enable.                 |
| K1  | DB24                        | I/O(3) | External Memory Data Bus — Bit 24.          |
| K2  | DB23                        | I/O(3) | External Memory Data Bus — Bit 23.          |
| КЗ  | DB22                        | I/O(3) | External Memory Data Bus — Bit 22.          |
| K4  | IACK1                       | O(3)   | Interrupt Acknowledge 1.                    |
| K5  | BRACKN                      | O(3)   | Bus Request Acknowledge.                    |
| K9  | Vss                         | P      | Ground.                                     |
| K10 | PDB09/<br>PIOP1             | I/O(3) | Parallel Data Bus — Bit 9/PIO Port — Bit 1. |
| K11 | PDB02                       | I/O(3) | Parallel Data Bus — Bit 2.                  |
| K12 | PDB01                       | I/O(3) | Parallel Data Bus — Bit 1.                  |
| K13 | PDB00                       | I/O(3) | Parallel Data Bus — Bit 0.                  |
| L1  | DB26                        | I/O(3) | External Memory Data Bus — Bit 26.          |
| L2  | DB25                        | I/O(3) | External Memory Data Bus — Bit 25.          |
| L3  | Vss                         | P      | Ground.                                     |
| L4  | INTREQ2                     |        | Interrupt Request 2.                        |

\* I = input; O = output; P = power; (3) = 3-state; (R) = on-chip pull-up.

† PAB3 is labeled PACK in the DSP32.

<sup>‡</sup> PIF is labeled PINT in the DSP32.

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### Pins by Numerical Order (continued)

#### Table 27. DSP32C Pin Descriptions—CPGA Package (continued)

Please refer to the AT&T DSP32C Information Manual for a complete description of each pin.

| Pin | Symbol          | Type*           | Name   |
|-----|-----------------|-----------------|--|
| L5  | INTREQ1         | l               | Interrupt Request 1.                         |
| L6  | BREQN           | I               | Bus Request.                                 |
| L7  | PDB15/<br>PIOP7 | I/O(3)          | Parallel Data Bus — Bit 15/PIO Port — Bit 7. |
| L8  | PDB14/<br>PIOP6 | I/O(3)          | Parallel Data Bus — Bit 14/PIO Port — Bit 6. |
| L9  | PDB13/<br>PIOP5 | I/O(3)          | Parallel Data Bus — Bit 13/PIO Port — Bit 5. |
| L10 | PDB10/<br>PIOP2 | I/O <u>(</u> 3) | Parallel Data Bus — Bit 10/PIO Port — Bit 2. |
| L11 | Vss             | P               | Ground.                                      |
| L12 | PDB04           | I/O(3)          | Parallel Data Bus — Bit 4.                   |
| L13 | PDB03           | I/O(3)          | Parallel Data Bus — Bit 3.                   |
| M1  | DB29            | I/O(3)          | External Memory Data Bus — Bit 29.           |
| M2  | DB28            | I/O(3)          | External Memory Data Bus — Bit 28.           |
| MЗ  | DB27            | I/O(3)          | External Memory Data Bus — Bit 27.           |
| M4  | DO              | O(3)            | Data Output.                                 |
| M5  | Vss             | Р               | Ground.                                      |
| M6  | SY              | I/O(3)          | Synchronization.                             |
| M7  | Vdd             | Ρ               | +5 V.  |
| M8  | ОСК             | I/O(3)          | Output Clock.                                |
| M9  | Vss             | Р               | Ground.                                      |
| M10 | PDB12/<br>PIOP4 | 1/O(3)          | Parallel Data Bus — Bit 12/PIO Port — Bit 4. |
| M11 | PDB07           | I/O(3)          | Parallel Data Bus — Bit 7.                   |
| M12 | PDB06           | I/O(3)          | Parallel Data Bus — Bit 6.                   |
| M13 | PDB05           | I/O(3)          | Parallel Data Bus — Bit 5.                   |
| N1  | DB31            | I/O(3)          | External Memory Data Bus — Bit 31.           |
| N2  | DB30            | I/O(3)          | External Memory Data Bus — Bit 30.           |
| N3  | OEN             | 1               | Output Enable.                               |
| N4  | OSE             | O(3)            | Output Shift Register Empty.                 |
| N5  | OBE             | O(3)            | Output Buffer Empty.                         |
| N6  | IBF             | O(3)            | Input Buffer Full.                           |
| N7  | OLD             | I/O(3)          | Output Load.                                 |
| N8  | ILD             | I/O(3)          | Input Load.                                  |

I = input; O = output; P = power; (3) = 3-state; (R) = on-chip pull-up.
 PAB3 is labeled PACK in the DSP32.

<sup>‡</sup> PIF is labeled PINT in the DSP32.

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### Pins by Numerical Order (continued)

### Table 27. DSP32C Pin Descriptions—CPGA Package (continued)

Please refer to the AT&T DSP32C Information Manual for a complete description of each pin.

| Pin | Symbol                     | Type*  | Name   |
|-----|----------------------------|--------|--|
| N9  | ICK                        | I/O(3) | Input Clock.                                 |
| N10 | DI                         | I      | Data Input.                                  |
| N11 | PDB11/<br>PIOP3            | I/O(3) | Parallel Data Bus — Bit 11/PIO Port — Bit 3. |
| N12 | PIF<br>(PINT) <sup>‡</sup> | O(3)   | Parallel Input Full.                         |
| N13 | PDF                        | O(3)   | Parallel Data Full.                          |

\* I = input; O = output; P = power; (3) = 3-state; (R) = on-chip pull-up.

PAB3 is labeled PACK in the DSP32.

<sup>‡</sup> PIF is labeled PINT in the DSP32.

#### Table 28. DSP32C Pin Descriptions—BQFP Package

Please refer to the AT&T DSP32C Information Manual for a complete description of each pin.

| Pin | Symbol | Type*  | Name                               |
|-----|--------|--------|------------------------------------|
| 1   | —      | NC     | —                                  |
| 2   | DB10   | I/O(3) | External Memory Data Bus — Bit 10. |
| 3   | DB12   | I/O(3) | External Memory Data Bus — Bit 12. |
| 4   | Vss    | Р      | Ground.                            |
| 5   | DB11   | I/O(3) | External Memory Data Bus — Bit 11. |
| 6   | DB13   | I/O(3) | External Memory Data Bus — Bit 13. |
| 7   | DB14   | I/O(3) | External Memory Data Bus — Bit 14. |
| 8   | Vdd    | Р      | +5 V.                              |
| 9   | DB15   | I/O(3) | External Memory Data Bus — Bit 15. |
| 10  | DB16   | I/O(3) | External Memory Data Bus — Bit 16. |
| 11  | DB17   | I/O(3) | External Memory Data Bus — Bit 17. |
| 12  | Vss    | Р      | Ground.                            |
| 13  | DB18   | I/O(3) | External Memory Data Bus — Bit 18. |
| 14  | DB19   | I/O(3) | External Memory Data Bus — Bit 19. |
| 15  | DB20   | I/O(3) | External Memory Data Bus — Bit 20. |
| 16  | Vdd    | Р      | +5 V.                              |
| 17  | IACK2  | O(3)   | Interrupt Acknowledge 2.           |
| 18  | IACK1  | O(3)   | Interrupt Acknowledge 1.           |
| 19  | BRACKN | O(3)   | Bus Request Acknowledge.           |
| 20  | _      | NC     | _                                  |
| 21  |        | NC     |                                    |

\* I = input; O = output; P = power; NC = no connection; (3) = 3-state; (R) = on-chip pull-up.

<sup>†</sup> PIF is labeled PINT in the DSP32.

<sup>‡</sup> PAB3 is labeled PACK in the DSP32.

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### Pins by Numerical Order (continued)

#### Table 28. DSP32C Pin Descriptions—BQFP Package (continued)

Please refer to the AT&T DSP32C Information Manual for a complete description of each pin.

| Pin | Symbol          | Type*  | Name   |
|-----|-----------------|--------|--|
| 22  | Vss             | Р      | Ground.                                      |
| 23  | INTREQ2         | I      | Interrupt Request 2.                         |
| 24  | INTREQ1         | 1      | Interrupt Request 1.                         |
| 25  | DB22            | I/O(3) | External Memory Data Bus — Bit 22.           |
| 26  | Vdd             | Р      | +5 V.  |
| 27  | DB21            | I/O(3) | External Memory Data Bus — Bit 21.           |
| 28  | BREQN           | 1      | Bus Request.                                 |
| 29  | DB23            | I/O(3) | External Memory Data Bus — Bit 23.           |
| 30  | Vss             | Р      | Ground.                                      |
| 31  | DB24            | I/O(3) | External Memory Data Bus — Bit 24.           |
| 32  | DB25            | I/O(3) | External Memory Data Bus — Bit 25.           |
| 33  | DB26            | I/O(3) | External Memory Data Bus — Bit 26.           |
| 34  | Vdd             | Р      | +5 V.  |
| 35  | DB29            | I/O(3) | External Memory Data Bus — Bit 29.           |
| 36  | DB28            | I/O(3) | External Memory Data Bus — Bit 28.           |
| 37  | DB27            | I/O(3) | External Memory Data Bus — Bit 27.           |
| 38  | Vss             | Р      | Ground.                                      |
| 39  | DB30            | I/O(3) | External Memory Data Bus — Bit 30.           |
| 40  | DB31            | I/O(3) | External Memory Data Bus — Bit 31.           |
| 41  | OEN             | 1      | Output Enable.                               |
| 42  | VDD             | Р      | +5 V.  |
| 43  | DO              | O(3)   | Data Output.                                 |
| 44  | OSE             | O(3)   | Output Shift Register Empty.                 |
| 45  | OBE             | O(3)   | Output Buffer Empty.                         |
| 46  | Vss             | P      | Ground.                                      |
| 47  | IBF             | O(3)   | Input Buffer Full.                           |
| 48  | SY              | I/O(3) | Synchronization.                             |
| 49  | OLD             | I/O(3) | Output Load.                                 |
| 50  | Vdd             | Р      | +5 V.  |
| 51  | OCK             | I/O(3) | Output Clock.                                |
| 52  | PDB15/<br>PIOP7 | I/O(3) | Parallel Data Bus — Bit 15/PIO Port — Bit 7. |
| 53  | PDB14/<br>PIOP6 | I/O(3) | Parallel Data Bus — Bit 14/PIO Port — Bit 6. |

\* i = input; O = output; P = power; NC = no connection; (3) = 3-state; (R) = on-chip pull-up.

<sup>†</sup> PIF is labeled PINT in the DSP32.

<sup>‡</sup> PAB3 is labeled PACK in the DSP32.

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### Pins by Numerical Order (continued)

#### Table 28. DSP32C Pin Descriptions—BQFP Package (continued)

Please refer to the AT&T DSP32C Information Manual for a complete description of each pin.

| Pin | Symbol                     | Type*  | Name   |
|-----|----------------------------|--------|--|
| 54  | Vss                        | Р      | Ground.                                      |
| 55  | ILD                        | I/O(3) | Input Load.                                  |
| 56  | ICK                        | I/O(3) | Input Clock.                                 |
| 57  | DI                         | 1      | Data Input.                                  |
| 58  | Vdd                        | Р      | +5 V.  |
| 59  | PDB13/<br>PIOP5            | I/O(3) | Parallel Data Bus — Bit 13/PIO Port — Bit 5. |
| 60  | PDB12/<br>PIOP4            | I/O(3) | Parallel Data Bus — Bit 12/PIO Port — Bit 4. |
| 61  | PDB11/<br>PIOP3            | I/O(3) | Parallel Data Bus — Bit 11/PIO Port — Bit 3. |
| 62  |                            | NC     | -  |
| 63  | _                          | NC     | —  |
| 64  | _                          | NC     |  |
| 65  | Vss                        | Р      | Ground.                                      |
| 66  | PDB08/<br>PIOP0            | I/O(3) | Parallel Data Bus — Bit 8/PIO Port — Bit 0.  |
| 67  | PDB09/<br>PIOP1            | I/O(3) | Parallel Data Bus — Bit 9/PIO Port — Bit 1.  |
| 68  | PDB10/<br>PIOP2            | I/O(3) | Parallel Data Bus — Bit 10/PIO Port — Bit 2. |
| 69  | Vdd                        | Р      | +5 V.  |
| 70  | PIF<br>(PINT) <sup>†</sup> | O(3)   | Parallel Interrupt Full.                     |
| 71  | PDF                        | O(3)   | Parallel Data Full.                          |
| 72  | PDB07                      | I/O(3) | Parallel Data Bus — Bit 7.                   |
| 73  | Vss                        | Р      | Ground.                                      |
| 74  | PDB06                      | I/O(3) | Parallel Data Bus — Bit 6.                   |
| 75  | PDB05                      | I/O(3) | Parallel Data Bus — Bit 5.                   |
| 76  | PDB04                      | I/O(3) | Parallel Data Bus — Bit 4.                   |
| 77  | VDD                        | Р      | +5 V.  |
| 78  | PDB03                      | I/O(3) | Parallel Data Bus — Bit 3.                   |
| 79  | PDB02                      | I/O(3) | Parallel Data Bus — Bit 2.                   |
| 80  | PDB01                      | I/O(3) | Parallel Data Bus — Bit 1.                   |
| 81  | Vss                        | Р      | Ground.                                      |

\* I = input; O = output; P = power; NC = no connection; (3) = 3-state; (R) = on-chip pull-up.

<sup>†</sup> PIF is labeled PINT in the DSP32.

<sup>‡</sup> PAB3 is labeled PACK in the DSP32.

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### Pins by Numerical Order (continued)

### Table 28. DSP32C Pin Descriptions—BQFP Package (continued)

Please refer to the AT&T DSP32C Information Manual for a complete description of each pin.

| Pin | Symbol                      | Туре*    | Name                                  |
|-----|-----------------------------|----------|---------------------------------------|
| 82  | PDB00                       | I/O(3)   | Parallel Data Bus — Bit 0.            |
| 83  |                             | NC       |                                       |
| 84  | PAB3<br>(PACK) <sup>‡</sup> | I        | Processor Address Bus — Bit 3.        |
| 85  | PEN                         | <u> </u> | Processor Interface Enable.           |
| 86  | Vdd                         | Р        | +5 V.                                 |
| 87  | PGN                         | I        | Processor Read Enable.                |
| 88  | PWN                         | l        | Processor Write Enable.               |
| 89  | PAB0                        | I        | Processor Address Bus — Bit 0.        |
| 90  | Vss                         | Р        | Ground.                               |
| 91  | PAB1                        | l        | Processor Address Bus — Bit 1.        |
| 92  | PAB2                        | I        | Processor Address Bus — Bit 2.        |
| 93  | СКО                         | O(3)     | Clock Out.                            |
| 94  | Vdd                         | Р        | +5 V.                                 |
| 95  | RESTN                       | I        | Reset.                                |
| 96  | CKI                         | I        | Clock In.                             |
| 97  | ZN                          | l(R)     | 3-State.                              |
| 98  | Vss                         | Р        | Ground.                               |
| 99  | MMD1                        | 1        | Memory Mode — Bit 1.                  |
| 100 | AB20                        | O(3)     | External Memory Address Bus — Bit 20. |
| 101 | MMD0                        |          | Memory Mode — Bit 0.                  |
| 102 | ł                           | NC       | —                                     |
| 103 | —                           | NC       | —                                     |
| 104 | EAPN                        | O(3)     | External Access Pending.              |
| 105 | Vdd                         | Р        | +5 V.                                 |
| 106 | AB21                        | O(3)     | External Memory Address Bus — Bit 21. |
| 107 | AB19                        | O(3)     | External Memory Address Bus — Bit 19. |
| 108 | AB00                        | O(3)     | External Memory Address Bus — Bit 0.  |
| 109 | Vss                         | Р        | Ground.                               |
| 110 | AB01                        | O(3)     | External Memory Address Bus — Bit 1.  |
| 111 | AB02                        | O(3)     | External Memory Address Bus — Bit 2.  |
| 112 | AB03                        | O(3)     | External Memory Address Bus — Bit 3.  |
| 113 | Vdd                         | Р        | +5 V.                                 |
| 114 | AB04                        | O(3)     | External Memory Address Bus — Bit 4.  |

\* I = input; O = output; P = power; NC = no connection; (3) = 3-state; (R) = on-chip pull-up.

<sup>†</sup> PIF is labeled PINT in the DSP32.

<sup>‡</sup> PAB3 is labeled PACK in the DSP32.

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### Pins by Numerical Order (continued)

#### Table 28. DSP32C Pin Descriptions—BQFP Package (continued)

Please refer to the AT&T DSP32C Information Manual for a complete description of each pin.

| Pin         | Symbol  | Type* | Name  |
|-------------|---------|-------|---|
| 115         | AB05    | O(3)  | External Memory Address Bus — Bit 5.          |
| 116         | AB18    | O(3)  | External Memory Address Bus — Bit 18.         |
| 117         | Vss     | Р     | Ground.                                       |
| 118         | AB06    | O(3)  | External Memory Address Bus — Bit 6.          |
| 119         | AB17    | O(3)  | External Memory Address Bus — Bit 17.         |
| 120         | AB07    | O(3)  | External Memory Address Bus — Bit 7.          |
| 121         | Vdd     | Р     | +5 V.   |
| 122         | AB09    | O(3)  | External Memory Address Bus — Bit 9.          |
| 123         | AB08    | O(3)  | External Memory Address Bus — Bit 8.          |
| 124         | AB10    | O(3)  | External Memory Address Bus — Bit 10.         |
| 125         | Vss     | Р     | Ground.                                       |
| 126         | AB16    | O(3)  | External Memory Address Bus — Bit 16.         |
| 127         | AB11    | O(3)  | External Memory Address Bus Bit 11.           |
| 128         | AB12    | O(3)  | External Memory Address Bus — Bit 12.         |
| 129         | Vdd     | Р     | +5 V.   |
| 130         | AB13    | O(3)  | External Memory Address Bus — Bit 13.         |
| 131         | AB14    | O(3)  | External Memory Address Bus — Bit 14.         |
| 132         | AB15    | O(3)  | External Memory Address Bus — Bit 15.         |
| 133         | Vss     | Р     | Ground.                                       |
| 134         | MSN0    | O(3)  | Memory Select — Bit 0.                        |
| 135         | MSN1    | O(3)  | Memory Select — Bit 1.                        |
| 136         | ASN     | O(3)  | Address Strobe.                               |
| 137         | Vdd     | Р     | +5 V.   |
| 138         | MSN2    | O(3)  | Memory Select — Bit 2.                        |
| 139         | MWN     | O(3)  | Memory Write.                                 |
| 140         | MSN3    | O(3)  | Memory Select — Bit 3.                        |
| 141         | Vss     | Р     | Ground.                                       |
| 142         | MGN     | O(3)  | Memory Output Enable/External Access Pending. |
| 143         | DSN     | O(3)  | Data Strobe.                                  |
| 144         | CYCLEIN | O(3)  | Cycle Initiate.                               |
| 145         |         | NC    |   |
| <b>1</b> 46 |         | NC    |   |
| 147         | Vdd     | Р     | +5 V.   |
| 148         | MMD2    | I     | Memory Mode — Bit 2.                          |

\* I = input; O = output; P = power; NC = no connection; (3) = 3-state; (R) = on-chip pull-up.

<sup>†</sup> PIF is labeled PINT in the DSP32.

<sup>‡</sup> PAB3 is labeled PACK in the DSP32.

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### Pins by Numerical Order (continued)

#### Table 28. DSP32C Pin Descriptions—BQFP Package (continued)

Please refer to the AT&T DSP32C Information Manual for a complete description of each pin.

| Pin | Symbol | Type*  | Name                              |
|-----|--------|--------|-----------------------------------|
| 149 | SRDYN  | I      | Synchronous Ready.                |
| 150 | RWN    | O(3)   | Read/Write.                       |
| 151 | Vss    | P      | Ground.                           |
| 152 | DB00   | I/O(3) | External Memory Data Bus — Bit 0. |
| 153 | DB01   | I/O(3) | External Memory Data Bus — Bit 1. |
| 154 | DB02   | I/O(3) | External Memory Data Bus — Bit 2. |
| 155 | Vdd    | Р      | +5 V.                             |
| 156 | DB03   | I/O(3) | External Memory Data Bus — Bit 3. |
| 157 | DB04   | I/O(3) | External Memory Data Bus — Bit 4. |
| 158 | DB05   | I/O(3) | External Memory Data Bus — Bit 5. |
| 159 | Vss    | Р      | Ground.                           |
| 160 | DB06   | I/O(3) | External Memory Data Bus — Bit 6. |
| 161 | DB07   | I/O(3) | External Memory Data Bus — Bit 7. |
| 162 | DB08   | I/O(3) | External Memory Data Bus — Bit 8. |
| 163 | Vdd    | Р      | +5 V.                             |
| 164 | DB09   | I/O(3) | External Memory Data Bus — Bit 9. |

\* I = input; O = output; P = power; NC = no connection; (3) = 3-state; (R) = on-chip pull-up.

<sup>†</sup> PIF is labeled PINT in the DSP32.

<sup>‡</sup> PAB3 is labeled PACK in the DSP32.

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## **Device Requirements and Characteristics**

### **Absolute Maximum Ratings**

Stresses in excess of the Absolute Maximum Ratings can cause permanent damage to the device. These are absolute stress ratings only. Functional operation of the device is not implied at these or any other conditions in excess of those given in the operational sections of the data sheet. Exposure to Absolute Maximum Ratings for extended periods can adversely affect device reliability.

#### Table 29. Absolute Maximum Ratings

| Parameter                                       | Min  | Max | Unit |
|---|------|-----|------|
| Voltage Range on Any Pin with Respect to Ground | -0.5 | 6.0 | V    |
| Power Dissipation                               | _    | 1.7 | W    |
| Storage Temperature                             | -65  | 150 | °C   |
| External Lead Bonding and Soldering Temperature |      | 300 | °C   |

Warning: All CMOS devices are prone to latch-up if excessive current is injected to/from the substrate. To prevent latch-up at powerup, no input pin should be subjected to input voltages greater than VIL, or less than Vss – 0.5 V before Vob is applied. After powerup, input should not be greater than VoD + 0.5 V or less than Vss – 0.5 V.

### **Handling Precautions**

All MOS devices must be handled with certain precautions to avoid damage due to the accumulation of static charge. Although input protection circuitry has been incorporated into the devices to minimize the effect of this static buildup, proper precautions should be taken to avoid exposure to electrostatic discharge during handling and mounting. AT&T employs a human-body model for ESD susceptibility testing. Since the failure voltage of electronic devices is dependent on the current and voltage and, hence, the resistance and capacitance, it is important that standard values be employed to establish a reference by which to compare test data. Values of 100 pF and 1500  $\Omega$  are the most common and are the values used in the AT&T human-body model test circuit. The breakdown voltage for the DSP32C is greater than 2000 V<sup>\*</sup>, according to the human-body model. ESD data for the charged-device model is available on request.

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<sup>\*</sup> The value of 2000 V for the breakdown voltage is subject to change. AT&T Microelectronics

### **Temperature Class Definitions**

### Table 30. Temperature Class Definitions

| Temperature<br>Class | Ambient Temperature TA (°C) |     |  |  |
|----------------------|-----------------------------|-----|--|--|
|                      | Min                         | Max |  |  |
| Commercial           | 0                           | 70  |  |  |
| Industrial           | -40                         | 85  |  |  |

### **Recommended Operating Conditions**

#### Table 31. Recommended Operating Conditions

| Device<br>Speed | Package      | Temperature<br>Class | Device Code     | Supply Voltage VDD (V) |      |  |
|-----------------|--------------|----------------------|-----------------|------------------------|------|--|
|                 |              |                      |                 | Min                    | Max  |  |
| 50 ns           | 133-Pin CPGA | Commercial           | DSP32C-R35050   | 4.75                   | 5.25 |  |
|                 | 164-Pin BQFP | Commercial           | DSP32C-F35050   | 4.75                   | 5.25 |  |
|                 | 133-Pin CPGA | Industrial           | DSP32C-R35050-I | 4.75                   | 5.25 |  |
| 60 ns           | 133-Pin CPGA | Commercial           | DSP32C-R35060   | 4.75                   | 5.25 |  |
|                 | 164-Pin BQFP | Commercial           | DSP32C-F35060   | 4.75                   | 5.25 |  |
|                 | 133-Pin CPGA | Industrial           | DSP32C-R35060-I | 4.75                   | 5.25 |  |
| 80 ns           | 133-Pin CPGA | Commercial           | DSP32C-R35080   | 4.5                    | 5.5  |  |
|                 | 164-Pin BQFP | Commercial           | DSP32C-F35080   | 4.5                    | 5.5  |  |
| :               | 133-Pin CPGA | Industrial           | DSP32C-R35080-I | 4.75                   | 5.25 |  |
|                 | 164-Pin BQFP | Industrial           | DSP32C-F35080-I | 4.75                   | 5.25 |  |

### **Package Thermal Considerations**

The recommended operating temperature specified above is based on the maximum power, package type, and maximum junction temperature. The following equation describes the relationship between these parameters. For certain applications, the maximum power may be less than the worst-case value and the following relationship can be used to determine the maximum ambient temperature allowed.

#### $TA = TJ - P \times \Theta JA$

| Maximum Junction Temperature (TJ) in 133-Pin CPGA                  | +125 °C |
|--|---------|
| 133-Pin CPGA Maximum Thermal Resistance in Still-Air-Ambient (ΘJA) | 25 °C/W |
| Maximum Junction Temperature (TJ) in 164-Pin BQFP                  | +125 °C |
| 164-Pin BQFP Maximum Thermal Resistance in Still-Air-Ambient (OJA) | 37 °C/W |

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## **Electrical Characteristics**

The parameters below are valid for the following conditions:

Commercial temperature class device: Industrial temperature class device:

 $T_A = 0 \circ C$  to 70  $\circ C$ ;  $V_{SS} = 0 V$ ;  $C_{LOAD} = 50 pF$ .

 $T_A = -40 \text{ °C to } +85 \text{ °C}; \text{ Vss} = 0 \text{ V}; \text{ CLOAD} = 50 \text{ pF}.$ 

| Parameter   | Sym  | Min       | Max      | Unit |
|---|------|-----------|----------|------|
| Input Voltage: All Pins Except PAB3—PAB0, PEN, PGN, PWN, OCK, |      |           |          |      |
| ICK, SY*  | VIL  | _         | 0.8      | v    |
| Low   |      |           |          |      |
| High (commercial temperature class device)                    | Ин   | 2.0       | —        | V    |
| High (industrial temperature class device)                    | Ин   | 2.2       | <u> </u> | V    |
| Input Voltage: Pins PAB3—PAB0, PEN, PGN, PWN, OCK, ICK, SY*   |      |           | ***-     |      |
| Low   | Vi∟  |           | 0.8      | V    |
| High (commercial temperature class device)                    | Ин   | 2.4       | <u> </u> | V V  |
| High (industrial temperature class device)                    | Viн  | 2.7       |          | V    |
| Output Low Voltage  |      |           |          |      |
| Low (IoL = 2 mA)  | Vol  | —         | 0.4      | V    |
| Low (IoL = 5 $\mu$ A)   | Vol  | —         | 0.2      | V    |
| Output High Voltage   |      |           |          |      |
| High (IoH = $-2 \text{ mA}$ )                                 | Voн  | Vdd - 0.7 | —        | V    |
| High (Іон = –5 µА)  | Vон  | Vdd - 0.2 | _        | V    |
| Input Leakage: All Inputs Except ZN                           |      |           |          |      |
| Low (VIL = 0 V) Low   | hL   | 5         |          | μA   |
| High (Vін = 5.5 V) High                                       | Ын   |           | 5        | μΑ   |
| Input Leakage: ZN <sup>†</sup> Pin                            |      |           |          |      |
| Low $(V l = 0 V)$ Low   | lı∟  | -500      |          | μA   |
| High (Vін = 5.5 V) High                                       | lн   |           | 5        | μΑ   |
| Output Offset Current   |      |           |          |      |
| Low (Vol = $0$ V)   | lozl | -10       | —        | μA   |
| High (Vон = 5.5 V)  | lozн | —         | 10       | μA   |
| Input, Output, I/O Capacitance                                | CI   | _         | 10       | pF   |
| Power Supply Current <sup>‡</sup>                             |      |           |          | ·    |
| Instruction Cycle Time = 50 ns; tCKILCKIL = 12.5 ns           | loo  |           | 306      | mA   |
| Instruction Cycle Time = 60 ns; tCKILCKIL = 15 ns             | ldd  | —         | 255      | mA   |
| Instruction Cycle Time = 80 ns; tCKILCKIL = 20 ns             | lod  |           | 225      | mA   |
| Power Dissipation§  |      |           |          |      |
| Instruction Cycle Time = 50 ns; tCKILCKIL = 12.5 ns           | PD   | —         | 1.7      | w    |
| Instruction Cycle Time = 60 ns; tCKILCKIL = 15 ns             | PD   |           | 1.4      | W    |
| Instruction Cycle Time = 80 ns; tCKILCKIL = 20 ns             | PD   |           | 1.25     | w    |

The ICK, OCK, and SY pins have Schmitt triggers with hysteresis in the range of 0.5 V to 0.8 V. This pin has a pull-up device.

Current in the input buffers is highly dependent on the input voltage level. At full CMOS levels, essentially no dc current is drawn, but for levels near the threshold of 1.4 V, high and unstable levels of current may flow. There are 72 inputs to the chip (19 input-only and 53 input/ output pins). If all inputs are connected to a dc voltage around 1.4 V, an additional current in the range of 150 mA can be drawn. This current can be almost totally eliminated by setting the input pins to CMOS voltage levels (Vob or Vss). Therefore, all unused inputs should be tied inactive to Vob or Vss and all unused I/O pins should be tied inactive through a 10 kΩ resistor to Vob or Vss.

The power dissipation listed is for output loads = 70 pF. Total power dissipation can be calculated on the basis of the application by adding §  $C \times V DD^2 \times f$  for each output, where C is the load capacitance and f is the output frequency.

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## **Timing Requirements and Characteristics**

The characteristics listed are valid under the following conditions:

Commercial temperature class device: $T_A = 0 \circ C$  to 70  $\circ C$ ; Vss = 0 V; CLOAD = 50 pF.Industrial temperature class device: $T_A = -40 \circ C$  to +85  $\circ C$ ; Vss = 0 V; CLOAD = 50 pF.

Output characteristics can be derated as a function of load capacitance (CL).

| All outputs except PDBs: | $dT/dC_{L} \le 0.04 \text{ ns/pF}$ for $0 \le C_{L} \le 100 \text{ pF}$ |
|--------------------------|---|
| PDB outputs:             | $dT/dC_{L} \le 0.11$ ns/pF for $0 \le C_{L} \le 200$ pF                 |

Test conditions for inputs:

- Rise and fall times of 4 ns or less
- Timing reference level for setup times is VIM = 1.5 V
- Timing reference levels for hold times:
   VIH = 2.0 V, VIL = 0.8 V

- Test conditions for outputs:
- CLOAD = 50 pF
- Timing reference level for delay times is
   VOM = 1.5 V
- Timing reference levels for hold times: VOH = 2.4 V, VOL = 0.4 V

### CKI and CKO Timing

| Table 32. | CKI and CKC | Timing | (See Figure 6.) |
|-----------|-------------|--------|-----------------|
|-----------|-------------|--------|-----------------|

| Abbreviated IEEE |           | Parameter 50 ns      |      | ns   | 60 ns |      | 80 ns |      | Unit |
|------------------|-----------|----------------------|------|------|-------|------|-------|------|------|
| Reference        | Symbol    |                      | Min  | Max  | Min   | Max  | Min   | Max  |      |
| t1               | tCKILCKIL | Clock In Period      | 12.5 | 500* | 15    | 500* | 20    | 500* | ns   |
| t2               | tCKILCKIH | Clock In Low         | 5.7  | _    | 6.8   |      | 9     |      | ns   |
| t3               | tCKIHCKIL | Clock In High        | 5.7  |      | 6.8   |      | 9     |      | ns   |
| t4               | tCKIRISE  | Clock In Rise Time   | _    | 3    | _     | 3.5  |       | 4    | ns   |
| t5               | tCKIFALL  | Clock In Fall Time   | -    | 3    |       | 3.5  | _     | 4    | ns   |
| t6               | tCKILCKOL | CKI Low to CKO Low   |      | 5    | _     | 6    |       | 8    | ns   |
| t6a              | tCKOFALL  | Clock Out Fall Time  | —    | 3    |       | 3.5  |       | 4    | ns   |
| t6b              | tCKORISE  | Clock Out Rise Time  |      | 3    | _     | 3.5  | _     | 4    | ns   |
| t7               | tCKIHCKOH | CKI High to CKO High | —    | 5    | _     | 6    |       | 8    | ns   |

\* The internal RAM contents are retained if CKI drops to DC, but the device is not guaranteed to function properly with CKI below 500 ns.

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## **External Memory Interface (EMI) Timing**

Table 33. Definition of Timing Characteristics for External Memory Interface (See Figures 7 and 8.)

| Abbreviated | IEEE            | Parameter                               |  |  |
|-------------|-----------------|---|--|--|
| Reference   | Symbol          |   |  |  |
| t8          | tCKOLABV        | CKO Low to Address Valid*               |  |  |
| t8a         | tCKOLABX        | Address Hold After CKO Low*             |  |  |
| t10         | tCKOLRWNV       | CKO Low to Read-Write Valid             |  |  |
| t10a        | tCKOLRWNX       | Read-Write Hold After CKO Low           |  |  |
| t11         | tCKOLCYCNL      | CKO Low to Cycle Initiate Low           |  |  |
| t12         | tCKOLCYCNH      | CKO Low to Cycle Initiate High          |  |  |
| t13         | tABVASNL        | Address Valid to Address Strobe Low*    |  |  |
| t13a        | tCKOHASNL       | CKO High to Address Strobe Low          |  |  |
| t14         | tASNLASNH       | Address Strobe Width                    |  |  |
| t14a        | tCKOLASNH       | CKO Low to Address Strobe High          |  |  |
| t14b        | <b>tASNHABX</b> | Address Hold After Address Strobe High* |  |  |
| t15         | tABVDSNH        | Data Strobe High After Address Valid*   |  |  |
| t15a        | tCKOLDSNL       | CKO Low to Data Strobe Low              |  |  |
| t15b        | tCKOLDSNH       | CKO Low to Data Strobe High             |  |  |
| t16         | tDSNLDSNH       | Data Strobe Width                       |  |  |
| t17         | tMGNLMGNH       | Read Data Strobe Width                  |  |  |
| t17b        | tMGNHMGNL       | Read Strobe High to Read Strobe Low     |  |  |
| t17c        | tCKOHMGNL       | CKO High to Read Strobe Low             |  |  |
| t17d        | tCKOLMGNH       | CKO Low to Read Strobe High             |  |  |
| t18         | tDSNHABX        | Address Hold After Data Strobe High*    |  |  |
| t20         | tDSNHRWNX       | Read-Write Hold After Data Strobe High  |  |  |
| t20a        | tDSNHDBE        | Data Strobe High to Data Bus Low-Z      |  |  |
| t20b        | tMGNHDBE        | Read Strobe High to Data Bus Low-Z      |  |  |
| t20c        | tRWNLDBE        | Read-Write Low to Data Bus Low-Z        |  |  |
| t21         | tDBVDSNH        | Data Bus Valid to Data Strobe High      |  |  |
| t21a        | tDSNHDBZ        | Data Strobe High to Data Bus Hi-Z       |  |  |
| t21c        | tCKOLDBZ        | Data Bus Hi-Z After CKO Low             |  |  |
| t21e        | tCKOLDBV        | CKO Low to Data Bus Valid               |  |  |
| t21f        | tCKOLDBE        | Data Bus Low-Z After CKO Low            |  |  |
| t22         | tDBVMWNH        | Data Bus Valid to Write Strobe High     |  |  |
| t22a        | tMWNLMWNH       | Write Strobe Width                      |  |  |
| t22b        | tCKOHMWNL       | CKO High to Write Strobe Low            |  |  |
| t22c        | tMWNHABX        | Address Hold After Write Strobe High*   |  |  |
| t22d        | tCKOHMWNH       | CKO High to Write Strobe High           |  |  |
| t23         | tABVMGNL        | Read Strobe Low After Address Valid*    |  |  |
| t23a        | tABVMWNL        | Write Strobe Low After Address Valid*   |  |  |

\* Timing of MSN0-MSN3 is the same as the address bus.

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## External Memory Interface (EMI) Timing (continued)

## Table 33. Definition of Timing Characteristics for External Memory Interface (continued)

(see Figures 7 and 8.)

| Abbreviated<br>Reference | <i>IEEE</i><br>Symbol | Parameter                               |
|--------------------------|-----------------------|---|
| t24                      | tABVDSNL              | Data Strobe Low After Address Valid*    |
| t24a                     | tMWNHDBZ              | Data Bus Hi-Z After Write Strobe High   |
| t24b                     | tASNHDBZ              | Data Bus Hi-Z After Address Strobe High |

\* Timing of MSN0---MSN3 is the same as the address bus.

### Table 34. Timing Characteristics for External Memory Interface (See Figures 7 and 8.)

| Abbreviated       | IEEE             | 50               | ns*      | 60               | ns*      | 80               | ns*      | Unit        |
|-------------------|------------------|------------------|----------|------------------|----------|------------------|----------|-------------|
| Reference         | Symbol           | Min              | Max      | Min              | Max      | Min              | Max      |             |
| t8†               | tCKOLABV         | 0                | 5        | 0                | 6        | 0                | 8        | ns          |
| t8a <sup>†</sup>  | tCKOLABX         | 0                | -        | 0                |          | 0                | -        | ns          |
| t10               | tCKOLRWNV        | 0                | 5        | 0 6              |          | 0                | 8        | ns          |
| t10a              | tCKOLRWNX        | 0                | _        | 0                |          | 0                |          | ns          |
| t11               | tCKOLCYCNL       | 0                | 4        | 0                | 5        | 0                | 6        | ns          |
| t12               | tCKOLCYCNH       | 0                | 4        | 0                | 5        | 0                | 6        | ns          |
| t13 <sup>†</sup>  | tABVASNL         | 0.5T – 1         | 0.5T + 3 | 0.5T – 1         | 0.5T + 3 | 0.5T – 3         | 0.5T + 3 | ns          |
| t13a              | tCKOHASNL        | 0                | 4        | 0                | 4        | 0                | 5        | ns          |
| t14               | tASNLASNH        | 1.5T – 2 +<br>NT | -        | 1.5T – 2<br>+ NT | _        | 1.5T – 2 +<br>NT |          | ns          |
| t14a              | tCKOLASNH        | 0                | 3        | 0                | 4        | 0                | ·5       | ns          |
| t14b <sup>†</sup> | tASNHABX         | 0                |          | 0                |          | 0                | _        | ns          |
| t15†              | tABVDSNH         | 2T – 3 +<br>NT   |          | 2T – 3 +<br>NT   |          | 2T – 5 +<br>NT   | _        | ns          |
| t15a              | tCKOLDSNL        | 0                | 3        | 0                | 4        | 0                | 5        | ns          |
| t15b              | tCKOLDSNH        | 0                | 3        | 0                | 4        | 0                | 5        | ns          |
| t16               | tDSNLDSNH        | T – 1 +<br>NT    |          | T – 1 +<br>NT    | _        | T – 2 +<br>NT    | —        | ns          |
| t17               | tMGNLMGNH        | 1.5T – 2<br>+ NT |          | 1.5T – 2<br>+ NT | _        | 1.5T – 4<br>+ NT | _        | . <b>ns</b> |
| t17b              | tMGNHMGNL        | 0.5T – 1         | _        | 0.5T – 1         | _        | 0.5T – 2         |          | ns          |
| t17c              | tCKOHMGNL        | 0                | 5        | 0                | 5        | 0                | 6        | ns          |
| t17d              | tCKOLMGNH        | 0                | 5        | 0                | 5        | 0                | 6        | ns          |
| t18†              | tDSNHABX         | 0                |          | 0                |          | 0                | _        | ns          |
| t20               | <b>tDSNHRWNX</b> | 0                | —        | 0                | _        | 0                |          | ns          |
| t20a              | tDSNHDBE         | Т                | _        | Т                |          | T 1              |          | ns          |
| t20b              | tMGNHDBE         | T-2              | _        | T – 2            | —        | T-4              | _        | ns          |

T = tCKILCKIL; N = number of wait-states; NT is the product of N and T.

<sup>†</sup> Timing of MSN0—MSN3 is the same as the address bus.

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## External Memory Interface (EMI) Timing (continued)

| Abbreviated | IEEE      | 50               | ns*      | 60               | ns*      | 80               | ns*      | Unit |
|-------------|-----------|------------------|----------|------------------|----------|------------------|----------|------|
| Reference   | Symbol    | Min              | Max      | Min              | Max      | Min              | Max      |      |
| t20c        | tRWNLDBE  | T – 1            | —        | T – 1            |          | T – 2            | -        | ns   |
| t21         | tDBVDSNH  | T – 3 +<br>NT    |          | T – 3 +<br>NT    | _        | T – 5 +<br>NT    | —        | ns   |
| t21a        | tDSNHDBZ  |                  | 2        |                  | 2        |                  | 2        | ns   |
| t21c        | tCKOLDBZ  | 0                | _        | 0                |          | 0                | _        | ns   |
| t21e        | tCKOLDBV  | 0                | 4        | 0                | 5        | 0                | 8        | ns   |
| t21f        | tCKOLDBE  | 0                | _        | 0                |          | 0                | _        | ns   |
| t22         | tDBVMWNH  | 0.5T – 2<br>+ NT |          | 0.5T – 2<br>+ NT | _        | 0.5T – 2<br>+ NT | —        | ns   |
| t22a        | tMWNLMWNH | T + NT           |          | T + NT           | _        | T + NT           | _        | ns   |
| t22b        | tCKOHMWNL | 0                | 4        | 0                | 5        | 0                | 7        | ns   |
| t22c        | tMWNHABX  | 0.5T – 2         |          | 0.5T – 3         | _        | 0.5T – 4         | _        | ns   |
| t22d        | tCKOHMWNH | 0                | 3        | 0                | 4        | 0                | 6        | ns   |
| t23         | tABVMGNL  | 0.5T – 2         |          | 0.5T – 3         |          | 0.5T – 4         |          | ns   |
| t23a        | tABVMWNL  | 0.5T – 2         | —        | 0.5T – 3         |          | 0.5T – 4         |          | ns   |
| t24         | tABVDSNL  | T – 2            |          | T – 3            |          | T – 4            |          | ns   |
| t24a        | tMWNHDBZ  | 0.5T – 2         | 0.5T + 2 | 0.5T – 2         | 0.5T + 3 | 0.5T – 2         | 0.5T + 4 | ns   |
| t24b        | tASNHDBZ  | -1               | 2        | -1               | 2        | -1               | 2        | ns   |

Table 34. Timing Characteristics for External Memory Interface (continued) (See Figures 7 and 8.)

\* T = tCKILCKIL; N = number of wait-states; NT is the product of N and T.

<sup>†</sup> Timing of MSN0—MSN3 is the same as the address bus.

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### External Memory Interface (EMI) Timing (continued)

### Table 35. Definition of Timing Requirements for External Memory Interface (See Figures 7 and 8.)

| Abbreviated | IEEE        | Parameter                              |
|-------------|-------------|--|
| Reference   | Symbol      |  |
| t25         | tSRDYNLCKOH | SRDYN Setup to CKO High                |
| t26         | tCKOHSRDYNH | SRDYN Hold After CKO High              |
| t27a        | tDBINASNH   | DATA in Setup to Address Strobe High   |
| t27c        | tDBINVCKOL  | DATA in Setup to CKO Low               |
| t27d        | tDBINVDSNH  | DATA in Setup to Data Strobe High      |
| t27m        | tDBINVMGNH  | DATA in Setup to Read Strobe High      |
| t28a        | tASNHDBX    | DATA in Hold After Address Strobe High |
| t28c        | tCKOLDBX    | DATA in Hold After CKO Low             |
| t28d        | tDSNHDBX    | DATA in Hold After Data Strobe High    |
| t28m        | tMGNHDBX    | DATA in Hold After Read Strobe High    |
| t29         | tABVDBINV   | Address Valid to DATA in Valid*        |
| t29a        | tASNLDBINV  | Address Strobe Low to DATA in Valid    |
| t29d        | tDSNLDBINV  | Data Strobe Low to DATA in Valid       |
| t29m        | tMGNLDBINV  | Read Strobe Low to DATA in Valid       |

\* Timing of MSN0—MSN3 is the same as the address bus.

| Table 36. | <b>Timing Requirements</b> | for External Memory | y Interface (See | Figures 7 and 8.) |
|-----------|----------------------------|---------------------|------------------|-------------------|
|-----------|----------------------------|---------------------|------------------|-------------------|

| Abbreviated      |     | 50 ns         |     | 60 ns         |     | 80 ns          | Unit |  |
|------------------|-----|---------------|-----|---------------|-----|----------------|------|--|
| Reference        | Min | Max*          | Min | Max*          | Min | Max*           |      |  |
| t25              | 4   | _             | 5   |               | 6   | <u> </u>       | ns   |  |
| t26              | 0   |               | 0   | —·            | 0   |                | ns   |  |
| t27a             | 6   |               | 7   | —             | 8   |                | ns   |  |
| t27c             | 3   | —             | 4   | —             | 5   |                | ns   |  |
| t27d             | 6   | —             | 7   | —             | 8   |                | ns   |  |
| t27m             | 8   | _             | 9   | —             | 10  | —              | ns   |  |
| t28a             | 0   | —             | 0   | —             | 0   |                | ns   |  |
| t28c             | 0   |               | 0   |               | 0   | —              | ns   |  |
| t28d             | 0   | —             | 0   |               | 0   | —              | ns   |  |
| t28m             | 0   |               | 0   | —             | 0   |                | ns   |  |
| t29 <sup>†</sup> |     | 2T – 7 + NT   | —   | 2T – 8 + NT   | —   | 2T – 10 + NT   | ns   |  |
| t29a             |     | 0.5T – 5 + NT | _   | 0.5T – 6 + NT | _   | 1.5T – 8 + NT  | ns   |  |
| t29d             | _   | T – 5 + NT    | _   | T – 6 + NT    |     | T – 8 + NT     | ns   |  |
| t29m             |     | 1.5T – 7 + NT |     | 1.5T – 8 + NT |     | 1.5T – 10 + NT | ns   |  |

\* T = tCKILCKIL; N = number of wait-states; NT is the product of N and T.

<sup>†</sup> Timing of MSN0—MSN3 is the same as the address bus.

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## Serial I/O (SIO) Timing

Note: Serial I/O is fully static; however, the maximum clock period (input and output) is tested only to the values stated in Table 37 and Table 38.

| Abbreviated | IEEE      | Parameter          | 50  | ns   | 60  | ns   | 80  | ns   | Unit |
|-------------|-----------|--------------------|-----|------|-----|------|-----|------|------|
| Reference   | Symbol    |                    | Min | Max  | Min | Max  | Min | Max  |      |
| t31         | tICKLICKL | Clock Period       | 25  | 1000 | 30  | 1000 | 40  | 1000 | ns   |
| t32         | tICKLICKH | Clock Low Time     | 11  |      | 13  |      | 18  |      | ns   |
| t33         | tICKHICKL | Clock High Time    | 11  | —    | 13  | _    | 18  |      | ns   |
| t34         | tILDHICKH | Load High Setup    | 5   | _    | 6   | _    | 8   | _    | ns   |
| t35         | tICKHILDX | Load High Hold     | 0   | —    | 0   |      | 0   |      | ns   |
| t36         | tILDLICKH | Load Low Setup     | 5   | —    | 6   | _    | 8   |      | ns   |
| t37         | tICKHILDX | Load Low Hold      | 0   | _    | 0   | _    | 0   |      | ns   |
| t38         | tDIVICKH  | Data Setup         | 5   | _    | 6   | _    | 8   |      | ns   |
| t39         | tICKHDIX  | Data Hold          | 0   |      | 0   | _    | 0   |      | ns   |
| t40         | tICKHIBFH | Input Buffer Delay | _   | 12   |     | 14   |     | 23   | ns   |

 Table 37. Timing Requirements and Characteristics for Serial Input (See Figure 9.)

#### Table 38. Timing Requirements for Serial Output (See Figure 10.)

| Abbreviated | IEEE             | Parameter       | 50  | ns   | 60  | ns   | 80  | ns   | Unit |
|-------------|------------------|-----------------|-----|------|-----|------|-----|------|------|
| Reference   | ference Symbol   |                 | Min | Max  | Min | Max  | Min | Max  |      |
| t41         | tOCKLOCKL        | Clock Period    | 25  | 1000 | 30  | 1000 | 40  | 1000 | ns   |
| t42         | <b>tOCKLOCKH</b> | Clock Low Time  | 11  |      | 13  | _    | 18  | _    | ns   |
| t43         | <b>tOCKHOCKL</b> | Clock High Time | 11  |      | 13  | _    | 18  |      | ns   |
| t44         | tOLDHOCKH        | Load High Setup | 5   |      | 6   |      | 8   | _    | ns   |
| t45         | tOCKHOLDX        | Load High Hold  | 0   |      | 0   |      | 0   |      | ns   |
| t46         | tOLDLOCKH        | Load Low Setup  | 5   |      | 6   |      | 8   |      | ns   |
| t47         | tOCKHOLDX        | Load Low Hold   | 0   |      | 0   |      | 0   |      | ns   |

### Table 39. Timing Characteristics for Serial Output (See Figure 10.)

| Abbreviated | IEEE      | Parameter                      | 50  | ns  | 60  | ns  | 80  | ns  | Unit |
|-------------|-----------|--------------------------------|-----|-----|-----|-----|-----|-----|------|
| Reference   | Symbol    |                                | Min | Max | Min | Max | Min | Max |      |
| t48         | tOCKHDOV  | Data Delay                     | _   | 12  | _   | 14  |     | 23  | ns   |
| t49         | tOCKHDOX  | Data Hold                      | 2   | _   | 2   | _   | 2   | _   | ns   |
| t50         | tOCKHOBEH | Output Buffer<br>Empty Delay   | _   | 12  | _   | 14  |     | 23  | ns   |
| t51         | tOCKHOSEH | Output Shift<br>Register Delay |     | 12  | _   | 14  |     | 23  | ns   |
| t52         | tOENLDOE  | Enable Delay                   |     | 12  | _   | 14  |     | 23  | ns   |
| t53         | tOENHDOZ  | Disable Delay                  | _   | 12  |     | 14  |     | 23  | ns   |

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## Timing Requirements and Characteristics (continued)

### Serial I/O (SIO) Timing (continued)

Note: Serial I/O is fully static; however, the maximum clock period (input and output) is tested only to the values stated in Table 37 and Table 38.

| Abbreviated | IEEE                 | Parameter*    | 50  | ns  | 60  | ns  | 80 ns |     | Unit |
|-------------|----------------------|---------------|-----|-----|-----|-----|-------|-----|------|
| Reference   | Symbol               |               | Min | Max | Min | Max | Min   | Max |      |
| t54         | tSYHICKH<br>tSYHOCKH | SY High Setup | 8   | _   | 8   | —   | 8     | —   | ns   |
| t55         | tICKHSYX<br>tOCKHSYX | SY High Hold  | 0   |     | 0   |     | 0     | _   | ns   |
| t56         | tSYLICKH<br>tSYLOCKH | SY Low Setup  | 8   |     | 8   | —   | 8     |     | ns   |
| t57         | tICKHSYX<br>tOCKHSYX | SY Low Hold   | 0   |     | 0   | —   | 0     |     | ns   |

 Table 40. Timing Requirements for Serial Clock Generation (See Figure 11.)

\* ICK or OCK is selected by ioc[1] (BC).

## Table 41. Timing Characteristics for Serial Clock Generation (See Figure 11.)

| Abbreviated | IEEE                   | Parameter*                | 50          | ns  | 60          | ns  | 80          | ns  | Unit |
|-------------|------------------------|---------------------------|-------------|-----|-------------|-----|-------------|-----|------|
| Reference   | Symbol                 |                           | Min         | Max | Min         | Max | Min         | Max |      |
| t58         | tICKHSYL<br>tOCKHSYL   | Internal SY Delay         |             | 12  |             | 14  |             | 23  | ns   |
| t59         | tICKHILDL<br>tOCKHOLDL | Internal Load<br>Delay    |             | 12  | _           | 14  | —           | 23  | ns   |
| t60         | tSYLILDL<br>tSYLOLDL   | Internal Load/SY<br>Delay |             | 12  |             | 14  |             | 23  | ns   |
| t61†        | tICKHICKH<br>tOCKHOCKH | Clock Period              | 300/<br>100 |     | 360/<br>120 |     | 480/<br>160 |     | ns   |
| t62†        | tICKLICKH<br>tOCKLOCKH | Clock Low Time            | 135/<br>35  |     | 165/<br>45  |     | 220/<br>60  |     | ns   |
| t63†        | tICKHICKL<br>tOCKHOCKL | Clock High Time           | 135/<br>35  | _   | 165/<br>45  | _   | 220/<br>60  |     | ns   |

\* ICK or OCK is selected by ioc[1] (BC).

† Depends on the value of the internal clock, determined by ioc[18] (CKI). Either CKI + 8 or CKI + 24.

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### Parallel I/O (PIO) Timing

| Abbreviated | IEEE      | Parameter             | 50   | 50 ns |      | 60 ns |      | 80 ns |    |
|-------------|-----------|-----------------------|------|-------|------|-------|------|-------|----|
| Reference   | Symbol    |                       | Min* | Max   | Min* | Max   | Min* | Max   |    |
| t64         | tPAVPRL   | Address Setup         | 5    |       | 6    | _     | 8    | _     | ns |
| t65         | tPRHPAX   | Address Hold          | 0    |       | 0    |       | 0    |       | ns |
| t70a        | tPRLPRH   | Read Pulse            | 2T   |       | 2T   | _     | 2T   | _     | ns |
| t76g        | tPRWHPRWL | PIO Idle <sup>†</sup> | 2T   | _     | 2T   |       | 2T   | -     | ns |

#### Table 42. Timing Requirements for PIO Read Cycle (See Figure 12.)

\* T = tCKILCKIL.

<sup>†</sup> A minimum 2T interval is required for the start of the read or write cycle following the end of the previous read or write cycle.

#### Table 43. Timing Characteristics for PIO Read Cycle (See Figure 12.)

| Abbreviated | IEEE    | Parameter           | 50   | ns  | 60   | ns  | 80   | ns  | Unit |
|-------------|---------|---------------------|------|-----|------|-----|------|-----|------|
| Reference   | Symbol  |                     | Min* | Max | Min* | Max | Min* | Max |      |
| t66         | tPRLPDV | Access from Read    |      | 17  | —    | 20  |      | 30  | ns   |
| t67         | tPRHPDZ | Data Hold from Read | 2    | 7   | 2    | 8   | 2    | 10  | ns   |

#### Table 44. Timing Requirements for PIO Write Cycle (See Figure 13.)

| Abbreviated | IEEE      | IEEE Parameter 50 ns  |      | ns  | 60   | ns  | 80 ns |     | Unit |  |
|-------------|-----------|-----------------------|------|-----|------|-----|-------|-----|------|--|
| Reference   | Symbol    |                       | Min* | Max | Min* | Max | Min*  | Max |      |  |
| t68         | tPAVPWL   | Address Setup         | 5    | _   | 6    |     | 8     | _   | ns   |  |
| t69         | tPWHPAX   | Address Hold          | 0    | _   | 0    |     | 0     |     | ns   |  |
| t70         | tPWLPWH   | Write Pulse           | 2T   | _   | 2T   |     | 2T    | _   | ns   |  |
| t71         | tPDVPWH   | Data Setup            | 10   | —   | 15   | _   | 20    |     | ns   |  |
| t72         | tPWHPDX   | Data Hold             | 0    | _   | 0    | _   | 0     | _   | ns   |  |
| t76g        | tPRWHPRWL | PIO Idle <sup>†</sup> | 2T   |     | 2T   | _   | 2T    |     | ns   |  |

\* T = tCKILCKIL.

<sup>†</sup> A minimum 2T interval is required for the start of the read or write cycle following the end of the previous read or write cycle.

#### Table 45. Timing Characteristics for PDF and PIF (See Figure 12 and Figure 13.)

| Abbreviated | IEEE     | Parameter       | 50  | 50 ns  |     | ) ns   | 8(  | ) ns   | Unit |
|-------------|----------|-----------------|-----|--------|-----|--------|-----|--------|------|
| Reference   | Symbol   |                 | Min | Max*   | Min | Max*   | Min | Max*   |      |
| t73         | tPWHPDFH | PDF Write Delay | _   | T + 15 | _   | T + 18 |     | T + 25 | ns   |
| t73a        | tPWHPIFH | PIF Write Delay | . — | T + 15 |     | T + 18 |     | T + 25 | ns   |
| t74         | tPRLPDFL | PDF Read Delay  | —   | 15     |     | 18     |     | 28     | ns   |
| t75         | tPRLPIFL | PIF Read Delay  |     | 15     | _   | 18     |     | 28     | ns   |
| t76a        | tPRHPDFL | PDF Read Delay  |     | T + 15 | _   | T + 18 |     | T + 25 | ns   |
| t76         | tPRHPIFL | PIF Read Delay  | _   | T + 15 |     | T + 18 |     | T + 25 | ns   |

\* T = tCKILCKIL.

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#### Parallel I/O (PIO) Timing (continued)

| Abbreviated | IEEE              | IEEE Parameter 50 ns 60 ns |      | ns  | ns 80 ns |     | Unit |     |    |
|-------------|-------------------|----------------------------|------|-----|----------|-----|------|-----|----|
| Reference   | Symbol            |                            | Min* | Max | Min*     | Max | Min* | Max |    |
| t76b        | <b>tPIOPVCKOL</b> | PIOP Setup                 | 7    | —   | 8        |     | 10   | —   | ns |
| t76c        | tCKOLPIOPX        | PIOP Hold                  | 0    | _   | 0        |     | 0    |     | ns |

#### Table 46. Timing Requirements and Characteristics for PIOP (See Figure 14.)

#### Table 47. Timing Requirements and Characteristics for PIOP (See Figure 14.)

| Abbreviated | IEEE       | Parameter         | 50 ns |     | neter 50 ns 60 ns 80 ns |     | rameter 50 ns 60 ns 80 n |     | 50 ns 60 ns |  | ns | Unit |
|-------------|------------|-------------------|-------|-----|-------------------------|-----|--------------------------|-----|-------------|--|----|------|
| Reference   | Symbol     |                   | Min*  | Max | Min*                    | Max | Min*                     | Max |             |  |    |      |
| t76d        | tCKOHPIOPX | PIOP Output Hold  | 4     | —   | 4                       |     | 5                        |     | ns          |  |    |      |
| t76e        | tCKOHPIOPV | PIOP Output Delay | _     | 15  | —                       | 20  | <u> </u>                 | 35  | ns          |  |    |      |

### **Reset and Interrupt Timing**

The following terms describe reset:

**Reset state** — The DSP32C is in the reset state when the internal reset signal is asserted, initializing the internal states of the chip. This state is entered when:

- Power-on reset is detected, or
- ZN and RESTN pins are low, or
- A 0-to-1 transition is detected on RESTN, or
- A 0-to-1 transition is detected on pcr[0] (only if RESTN = 1).

**Powerup reset** — Powerup reset occurs during the first eight clock cycles after power has been applied  $(V_{DD} \ge 3 V)$ . On-chip circuitry detects powerup and puts the chip in the reset state.

**Reset sequence** — The reset sequence is the execution of the internally generated instructions **call 0 (r14)** followed by **nop**. The reset sequence always follows the reset state.

**Halt mode** — The DSP32C is executing internally generated nops during the halt mode. PIO DMA remains active.

**Run mode** — The DSP32C is fetching and executing instructions.

**Powerup reset sequences.** On powerup of the DSP32C, on-chip circuitry puts the device in the reset state for the first eight clock cycles.

At this time, the logic levels of RESTN and ZN (both are active-low) control the DSP32C's operation:

| ZN | RESTN | Description                       |
|----|-------|-----------------------------------|
| 0  | 0     | Remain in the reset state.        |
| X* | 1     | Perform reset sequence then run.  |
| 1  | 0     | Perform reset sequence then halt. |

\* x denotes don't care.

**Reset and halt operation.** While in the run mode, the DSP32C can be placed in other modes by asserting the RESTN and ZN pins or by using the **pcr** register. To enter the halt mode, assert RESTN or write **pcr[0]** = 0. Note that RESTN has priority over **pcr[0]**. To bring the chip out of the halt mode, deassert RESTN or write **pcr[0]** = 1. This initiates a reset state followed by the reset sequence followed by the run mode.

To enter the reset state immediately, assert ZN and RESTN. Subsequent operations are the same as on powerup.

To enter the halt mode using only the RESTN signal (see Figure 18):

- 1. Assert RESTN.
- 2. Deassert RESTN. The reset state is performed, followed by the reset sequence.
- Assert RESTN, again, within 10 clock cycles. The DSP32C enters the halt mode without executing any instructions.

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### Reset and Interrupt Timing (continued)

#### Table 48. Definition of Timing Requirements and Characteristics for Interrupts and Reset (see Figure 15, Figure 18, and Figure 19)

| Abbreviated | IEEE            | Parameter   |
|-------------|-----------------|---|
| Reference   | Symbol          |   |
| t77         | tINTREQLINTREQH | INTREQ Assertion to Guarantee Interrupt Is Recognized |
| t78         | tIACKHINTREQH   | Interrupt Acknowledge to Request Deassertion          |
| t79         | tRESTNLRESTNH   | RESTN Assertion to Guarantee Reset                    |
| t79a        | tPUSV           | Powerup to RESTN and ZN Valid                         |
| t79b        | tRESTNHZNH      | RESTN High to ZN High                                 |
| t79c        | tHALT           | RESTN High to RESTN Low (enter halt after reset)      |
| t80         | tCKOLIACKH      | Interrupt Acknowledge Asserted with Respect to CKO    |

#### Table 49. Timing Requirements and Characteristics for Interrupts and Reset (see Figure 15, Figure 18, and Figure 19)

| Abbreviated | obreviated 50 |         | 60     | ns*     | 80      | ns*     | Unit |  |
|-------------|---------------|---------|--------|---------|---------|---------|------|--|
| Reference   | Min           | Max     | Min    | Max     | Min     | Max     |      |  |
| t77         | 4T + 6        |         | 4T + 8 | —       | 4T + 10 | —       | ns   |  |
| t78         |               | 2T      |        | 2T      |         | 2T      | ns   |  |
| t79         | 4T – 6        | —       | 4T – 8 | —       | 4T – 10 |         | ns   |  |
| t79a        | 0             | 4T – 10 | 0      | 4T – 10 | 0       | 4T – 10 | ns   |  |
| t79b        |               | 8T†     | 1      | 8T†     |         | 8T†     | ns   |  |
| t79c        | _             | 10T     | _      | 10T     |         | 10T     | ns   |  |
| t80         |               | 7       |        | 8       | _       | 10      | ns   |  |

\* T = tCKILCKIL.

TXN may be asserted at any time. This maximum specification permits correct DSP32C operation. Assertion of ZN for longer than 8T keeps all DSP32C outputs in a high-impedance state.

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### **Bus Request Timing**

#### Table 50. Definition of Timing Requirements and Characteristics for Bus Request (See Figure 16 and Figure 17.)

| Abbreviated | IEEE               | Parameter                                    |
|-------------|--------------------|--|
| Reference   | Symbol             |  |
| t81         | <b>tBREQNLCKOL</b> | BREQN Setup Time to CKO Low                  |
| t82         | tCKOLCKOH          | Synchronous Bus Request Interval             |
| t83         | tCKOHBRACKNL       | BRACKN Delay After CKO High                  |
| t84         | tBRACKNLABZ        | BRACKN Asserted to EMI High Impedance        |
| t85         | tBREQNHCKOL        | BREQN Setup Time to CKO Low                  |
| t86         | tCKOLCKOH          | Synchronous Bus Request Deassertion Interval |
| t87         | tCKOHBRACKNH       | BRACKN Delay After CKO High                  |
| t88         | tBRACKNHABV        | BRACKN Deasserted to EMI Signals Active      |
| t89         | tCKOLMGNL          | MGN/EAPN Asserted After CKO Low              |
| t90         | tCKOLMGNH          | MGN/EAPN Deasserted After CKO Low            |

#### Table 51. Timing Requirements and Characteristics for Bus Request

(See Figure 16 and Figure 17.)

| Abbreviated | 50   | ) ns*     | 60   | ) ns*     | 80   | 80 ns*    |    |  |
|-------------|------|-----------|------|-----------|------|-----------|----|--|
| Reference   | Min  | Max       | Min  | Max       | Min  | Max       |    |  |
| t81         | 6    |           | 7    |           | 8    | —         | ns |  |
| t82         | 2.5T | 3.5T + NT | 2.5T | 3.5T + NT | 2.5T | 3.5T + NT | ns |  |
| t83         |      | 6         | _    | 7         | —    | 8         | ns |  |
| t84         |      | 0         |      | 0         | —    | 0         | ns |  |
| t85         | 6    |           | 7    | _         | 8    | _         | ns |  |
| t86         | 1.5T |           | 1.5T |           | 1.5T | _         | ns |  |
| t87         | _    | 6         | —    | 7         |      | 8         | ns |  |
| t88         | 0    |           | 0    | _         | 0    | _         | ns |  |
| t89         |      | 6         | —    | 7         |      | 8         | ns |  |
| t90         | —    | 6         |      | 7         | _    | 8         | ns |  |

\* T = tCKILCKIL; N = number of wait-states in external memory transaction; NT is the product of N and T.

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## **Timing Diagrams**

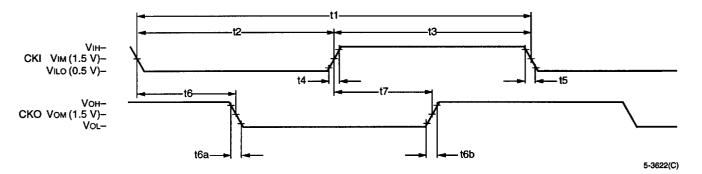
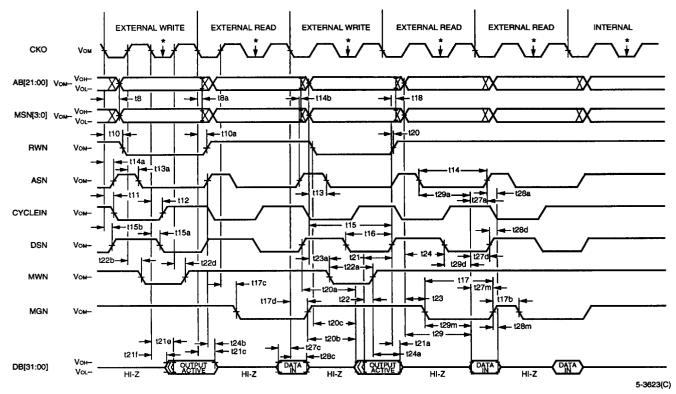


Figure 6. Clock In and Clock Out



\* Additional clock periods are added here for memory waits.

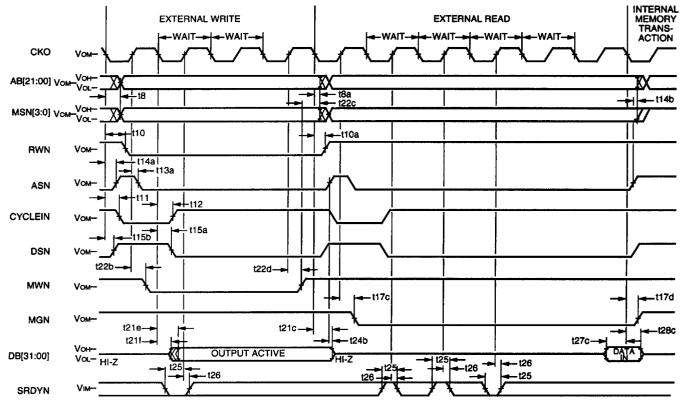


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### AT&T DSP32C Digital Signal Processor with External Memory Interface

## Timing Diagrams (continued)



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Note: SRDYN assertion is not necessary for wait-states programmed with pcw[MEMA]/pcw[MEMB] = 00, 01, or 10 and pcw[WA]/pcw[WB] = 1.

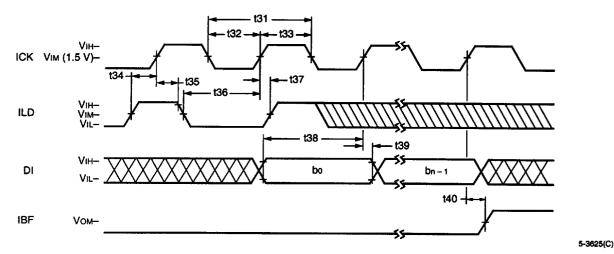
#### Figure 8. External Memory Transactions (Wait-States from External Memory)

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## Timing Diagrams (continued)





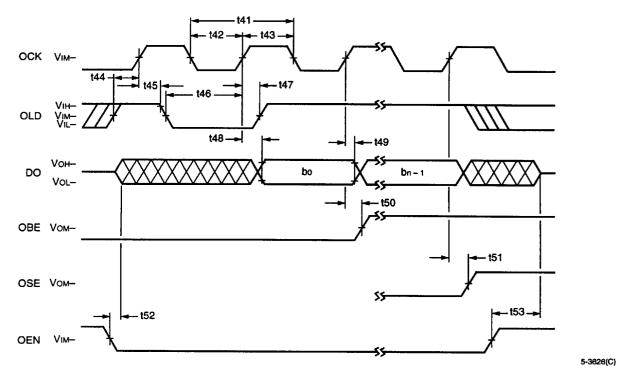
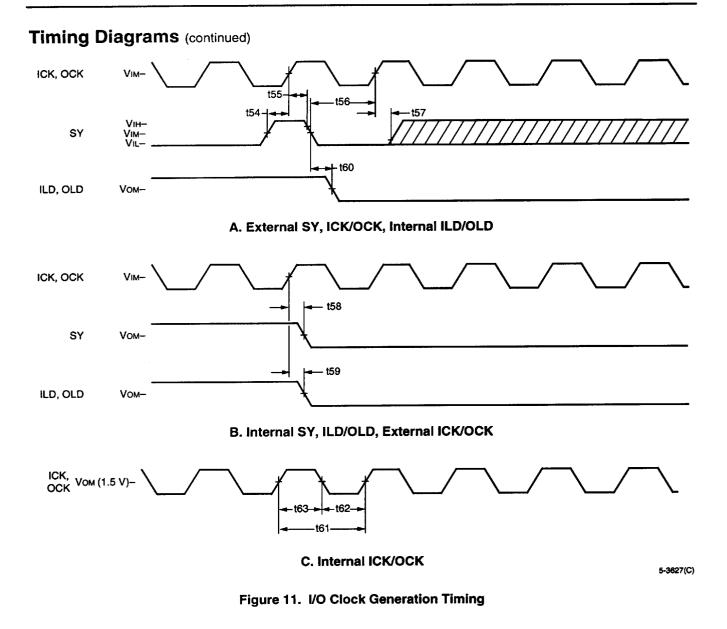


Figure 10. Serial Output Timing

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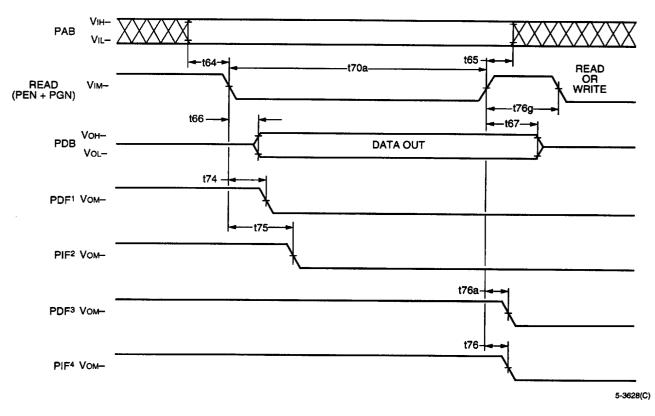


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### Timing Diagrams (continued)



- 1. PDF changes at the beginning of a read transaction when pcr[10] = 0. PDF changes only when pdr(h) (8-bit mode) or pdr (16-bit mode) is read. Reading pdr(l), pdr2(l), or pdr2(h) (8-bit mode), or reading pdr2 (16-bit mode) does not affect the PDF flag.
- 2. PIF changes at the beginning of a read transaction if pcr[10] = 0. If PIF high was caused by the loading of the pir register, PIF changes when pir (h) (8-bit mode) is read, or pir(w) (16-bit mode) is read and pcr[2] (ENI) is set (1).
- 3. PDF changes at the end of a read transaction if pcr[10] = 1. (See Note 1 for a description of PDF logic.)
- PIF changes at the end of a read transaction if pcr[10] = 1. (See Note 2 for a description of PIF logic.) PIF also changes when the esr register is read (if PIF high was caused by an unmasked error).

Figure 12. PIO Timing — Read Cycle

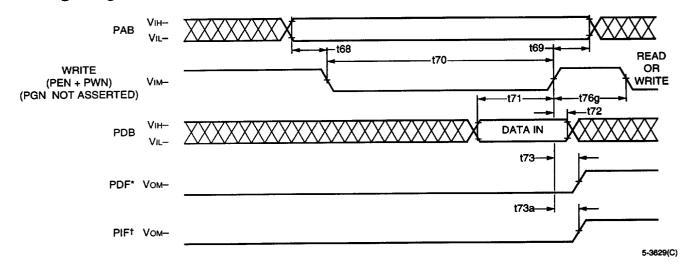
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### AT&T DSP32C Digital Signal Processor with External Memory Interface

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### Timing Diagrams (continued)



PDF changes only when pdr(h) (8-bit mode) or pdr (16-bit mode) is written. Writing pdr(l), pdr2(l), pdr2(h) (8-bit mode), or writing pdr2 (16-bit mode) does not affect the PDF flag.

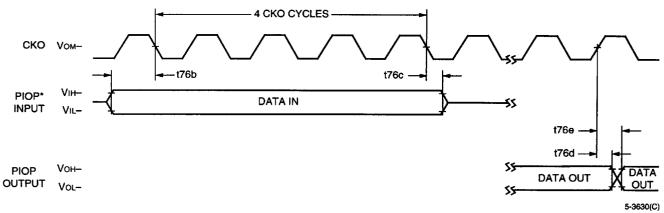
t If pcr[2] (ENI) is set (1), PIF changes when pir(h) (8-bit mode) or pir (16-bit mode) is written.

Figure 13. PIO Timing — Write Cycle (PGN High)

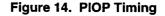
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### Timing Diagrams (continued)



Note: The PIOP inputs are intended to sense slowly changing events. The DSP32C samples PIOP inputs once every four cycles of CKO; the value of PIOP read reflects the PIOP when sampled by a DSP32C instruction that reads the PIOP register.



#### 8-Bit PIO

When the DSP32C PIO is configured as an 8-bit port, the upper 8 bits of PDB can be configured by **pcw[7—6]** to be two 4-bit input or output registers. The upper 8 bits of PDB are referred to as PIOP0—PIOP7.

When either PIOP0—PIOP3 or PIOP4—PIOP7 is configured as an input, the PIOP register can be read by the DSP32C, at most, once every four cycles of CKO.

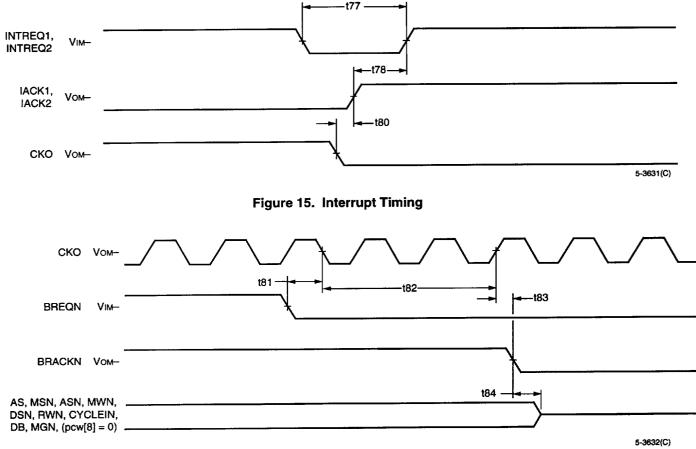
When either PIOP0—PIOP3 or PIOP4—PIOP7 is configured as an output, the corresponding bits of PDB change only when the DSP32C program writes a different value to the corresponding bit in PIOP, or if **pcw[6]** (PIOPL) or **pcw[7]** (PIOPH) is cleared. This may occur, at most, once every four cycles of CKO. (When **pcw[6]** or **pcw[7]** is cleared, the corresponding bits of PDB become inputs, but the contents of the PIOP registers remain unchanged.)

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# Timing Diagrams (continued)



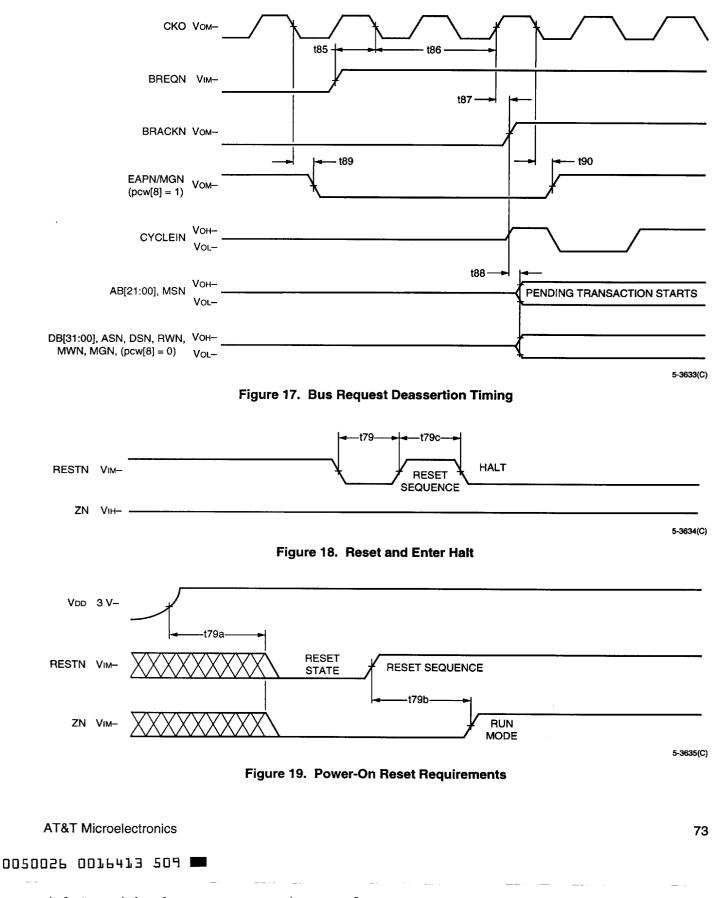


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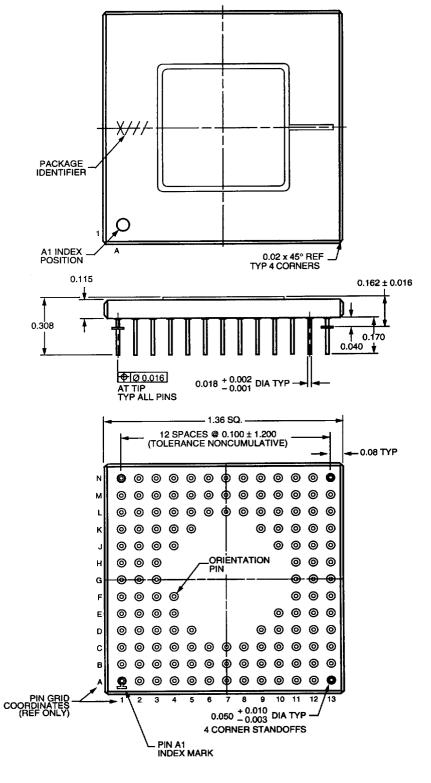
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## Timing Diagrams (continued)



## **Outline Diagrams**

133-Pin CPGA Package (all dimensions are in inches)



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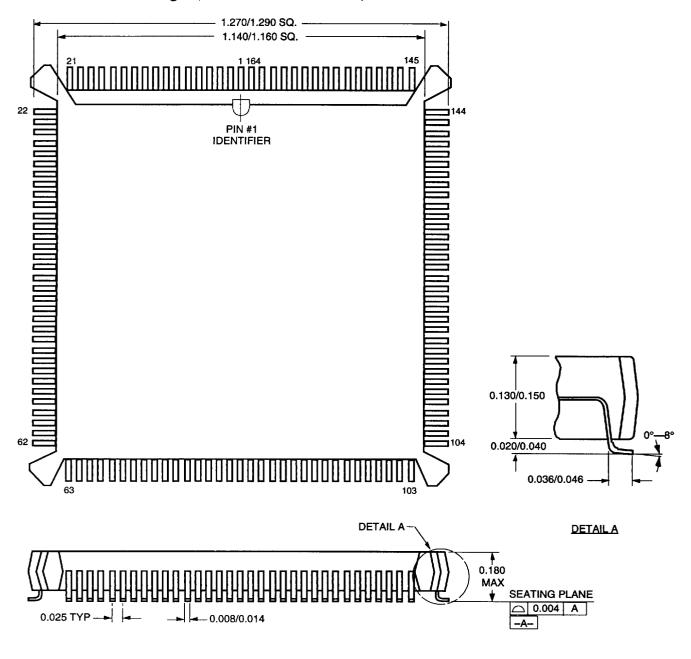
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## **Outlines Diagrams** (continued)

164-Pin BQFP Package (all dimensions are in inches)



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